

# USB5916

# 6-Port USB 3.1 Gen 1 Smart Hub with Support for a USB Type-C<sup>TM</sup> UFP and DFP

#### Highlights

- USB Hub Feature Controller Hub with:
  - 1 USB 3.1 Gen 1 USB Type-C<sup>™</sup> downstream port
  - 4 USB 3.1 Gen 1 legacy downstream ports
  - 1 USB 2.0 legacy downstream port
  - USB Type-C upstream port
- USB-IF Battery Charger revision 1.2 support on up & downstream ports (DCP, CDP, SDP)
- Internal Hub Feature Controller device enables:
  - USB to I $^2$ C/SPI/GPIO bridge endpoint support
  - USB to internal hub register write and read
- USB Link Power Management (LPM) support
- Enhanced OEM configuration options available through either OTP or SPI ROM
- Available in 100-pin (12mm x 12mm) VQFN RoHS compliant package
- Commercial and industrial grade temperature support

#### **Target Applications**

- Standalone USB Hubs
- · Laptop Docks
- PC Motherboards
- PC Monitor Docks
- Multi-function USB 3.1 Gen 1 Peripherals

#### **Key Benefits**

- USB 3.1 Gen 1 compliant 5 Gbps, 480 Mbps, 12 Mbps, and 1.5Mbps operation
  - 5V tolerant USB 2.0 pins
  - 1.32V tolerant USB 3.1 Gen 1 pins
  - Integrated termination and pull-up/down resistors
- Native USB Type-C Support
  - Integrated Multiplexer on USB Type-C enabled ports
  - USB 3.1 Gen 1 PHYs are disabled until a valid USB Type-C attach is detected, saving idle power

- Supports battery charging of most popular battery powered devices on all ports
  - USB-IF Battery Charging rev. 1.2 support (DCP, CDP, SDP)
  - Apple<sup>®</sup> portable product charger emulation
  - Chinese YD/T 1591-2006 charger emulation
  - Chinese YD/T 1591-2009 charger emulation
  - European Union universal mobile charger support
  - Support for Microchip UCS100x family of battery charging controllers
  - Supports additional portable devices
- · Smart port controller operation
  - Firmware handling of companion port power controllers
- On-chip microcontroller
  - manages I/Os, VBUS, and other signals
- 8 KB RAM, 64 KB ROM
- 8 KB One-Time-Programmable (OTP) ROM
  - Includes on-chip charge pump
- Configuration programming via OTP ROM, SPI ROM, or SMBus
- PortSwap
  - Configurable USB 2.0 differential pair signal swap
- PHYBoost<sup>TM</sup>
  - Programmable USB transceiver drive strength for recovering signal integrity
- VariSense<sup>™</sup>
  - Programmable USB receive sensitivity
- Port Split
  - USB2.0 and USB3.1 Gen1 port operation can be split for custom applications using embedded USB3.x devices in parallel with USB2.0 devices.
- · USB Power Delivery Billboard Device Support
  - Internal port can enumerate as a Power Delivery Billboard device to communicate Power Delivery Alternate Mode negotiation failure cases to USB host
- Compatible with Microsoft Windows 10, 8, 7, XP, Apple OS X 10.4+, and Linux hub drivers
- Optimized for low-power operation and low thermal dissipation
- Package
  - 100-pin VQFN (12mm x 12mm)

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# 1.0 PREFACE

#### 1.1 General Terms

#### TABLE 1-1: GENERAL TERMS

Term	Description				
ADC	Analog-to-Digital Converter				
Byte	8 bits				
CDC	Communication Device Class				
CSR	Control and Status Registers				
DWORD	32 bits				
EOP	End of Packet				
EP	Endpoint				
FIFO	First In First Out buffer				
FS	Full-Speed				
FSM	Finite State Machine				
GPIO	General Purpose I/O				
HS	Hi-Speed				
HSOS	High Speed Over Sampling				
Hub Feature Controller	The Hub Feature Controller, sometimes called a Hub Controller for short is the internal processor used to enable the unique features of the USB Controller Hub. This is not to be confused with the USB Hub Controller that is used to communicate the hub status back to the Host during a USB session.				
l <sup>2</sup> C	Inter-Integrated Circuit				
LS	Low-Speed				
lsb	Least Significant Bit				
LSB	Least Significant Byte				
msb	Most Significant Bit				
MSB	Most Significant Byte				
N/A	Not Applicable				
NC	No Connect				
ОТР	One Time Programmable				
РСВ	Printed Circuit Board				
PCS	Physical Coding Sublayer				
PHY	Physical Layer				
PLL	Phase Lock Loop				
RESERVED	Refers to a reserved bit field or address. Unless otherwise noted, reserved bits must always be zero for write operations. Unless otherwise noted, values are not guaran- teed when reading reserved bits. Unless otherwise noted, do not read or write to reserved addresses.				
SDK	Software Development Kit				
SMBus	System Management Bus				
UUID	Universally Unique IDentifier				
WORD	16 bits				

#### **1.2** Reference Documents

- 1. UNICODE UTF-16LE For String Descriptors USB Engineering Change Notice, December 29th, 2004, http:// www.usb.org
- 2. Universal Serial Bus Revision 3.1 Specification, http://www.usb.org
- 3. Battery Charging Specification, Revision 1.2, Dec. 07, 2010, http://www.usb.org
- 4. *I*<sup>2</sup>*C-Bus Specification*, Version 1.1, http://www.nxp.com
- 5. System Management Bus Specification, Version 1.0, http://smbus.org/specs

# 2.0 INTRODUCTION

#### 2.1 General Description

The Microchip USB5916 hub is a low-power, OEM configurable, USB 3.1 Gen 1 hub controller with 6 downstream ports and advanced features for embedded USB applications. The USB5916 is fully compliant with the Universal Serial Bus Revision 3.1 Specification and USB 2.0 Link Power Management Addendum. The USB5916 supports 5 Gbps Super-Speed (SS), 480 Mbps Hi-Speed (HS), 12 Mbps Full-Speed (FS), and 1.5 Mbps Low-Speed (LS) USB downstream devices on all enabled downstream ports.

The USB5916 supports the legacy USB speeds (HS/FS/LS) through a dedicated USB 2.0 hub controller that is the culmination of five generations of Microchip hub controller design and experience with proven reliability, interoperability, and device compatibility. The SuperSpeed hub controller operates in parallel with the USB 2.0 hub controller, decoupling the 5 Gbps SS data transfers from bottlenecks due to the slower USB 2.0 traffic.

The USB5916 hub feature controller enables OEMs to configure their system using "Configuration Straps." These straps simplify the configuration process, assigning default values to USB 3.1 Gen 1 ports and GPIOs. OEMs can disable ports, enable battery charging, and define GPIO functions as default assignments on power-up, removing the need for OTP or external SPI ROM.

The USB5916 supports downstream battery charging via the integrated battery charger detection circuitry, which supports the USB-IF Battery Charging (BC1.2) detection method and most Apple devices. The USB5916 provides the battery charging handshake and supports the following USB-IF BC1.2 charging profiles:

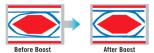
- DCP: Dedicated Charging Port (Power brick with no data)
- CDP: Charging Downstream Port (1.5A with data)
- · SDP: Standard Downstream Port (0.5A with data)
- · Custom profiles loaded via SMBus or OTP

Additionally, the USB5916 includes many powerful and unique features such as:

**The Hub Feature Controller**, which provides an internal USB device dedicated for use as a USB to I<sup>2</sup>C/UART/SPI/ GPIO interface, allowing external circuits or devices to be monitored, controlled, or configured via the USB interface.

**PortSwap**, which adds per-port programmability to USB differential-pair pin locations. PortSwap allows direct alignment of USB signals (D+/D-) to connectors to avoid uneven trace length or crossing of the USB differential signals on the PCB.

**PHYBoost**, which provides programmable levels of Hi-Speed USB signal drive strength in the downstream port transceivers. PHYBoost attempts to restore USB signal integrity in a compromised system environment. The graphic on the right shows an example of Hi-Speed USB eye diagrams before and after PHYBoost signal integrity restoration. in a compromised system environment.



**VariSense**, which controls the USB receiver sensitivity enabling programmable levels of USB signal receive sensitivity. This capability allows operation in a sub-optimal system environment, such as when a captive USB cable is used.

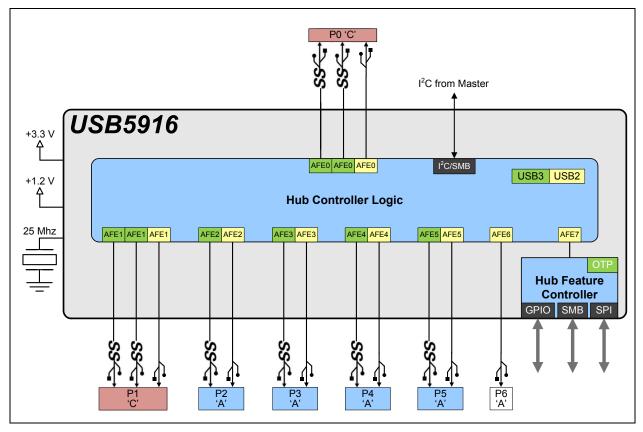
**Port Split**, which allows for the USB3.1 Gen1 and USB2.0 portions of downstream ports 4 and 5to operate independently and enumerate two separate devices in parallel in special applications.

**USB Power Delivery Billboard Device**, which allows an internal device to enumerate as a Billboard class device when a Power Delivery Alternate Mode negotiation has failed. The Billboard device will enumerate temporarily to the host PC when a failure occurs, as indicated by a digital signal from an external Power Delivery controller.

The USB5916 can be configured for operation through internal default settings. Custom OEM configurations are supported through external SPI ROM or OTP ROM. All port control signal pins are under firmware control in order to allow for maximum operational flexibility, and are available as GPIOs for customer specific use.

The USB5916 is available in commercial (0°C to +70°C) and industrial (-40°C to +85°C) temperature ranges. An internal block diagram of the USB5916 is shown in Figure 2-1.



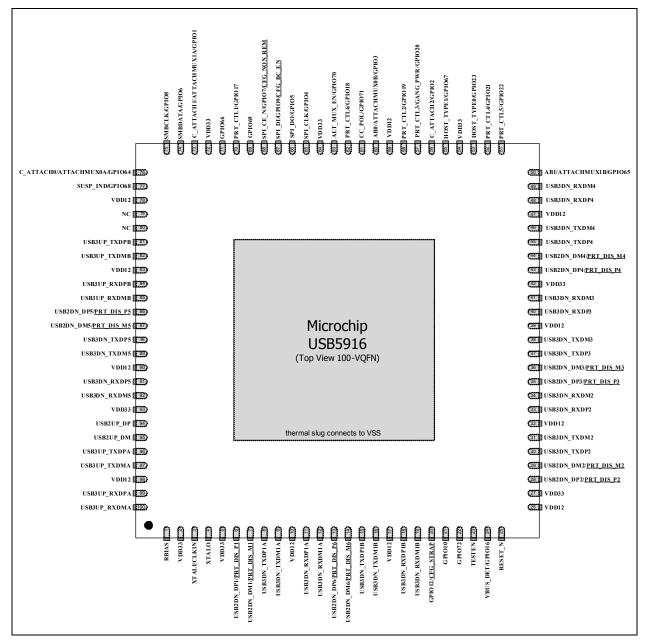


# USB5916

# 3.0 PIN DESCRIPTIONS

# 3.1 Pin Diagram

# FIGURE 3-1: PIN ASSIGNMENTS (TOP VIEW)



**Note 1:** Configuration straps are identified by an underlined symbol name. Signals that function as configuration straps must be augmented with an external resistor when connected to a load. Refer to Section 3.5, Configuration Straps and Programmable Functions

# 3.2 Pin Symbols

Pin Num.	Pin Name	Reset	Pin Num.	Pin Name	Reset
1	RBIAS	A/P	51	PRT_CTL5/GPIO22	PD-50k
2	VDD33	A/P	52	PRT_CTL4/GPIO21	PD-50k
3	XTALI/CLKIN	A/P	53	HOST_TYPE0/GPIO23	PD-50k
4	XTALO	A/P	54	VDD33	A/P
5	VDD33	A/P	55	HOST_TYPE1/GPIO67	Z
6	USB2DN DP1/PRT DIS P1	PD-15k	56	C ATTACH2/GPIO2	Z
7	USB2DN DM1/ <u>PRT DIS M1</u>	PD-15k	57	PRT CTL3/GANG PWR/GPIO20	PD-50k
8	USB3DN TXDP1A	Z	58	PRT CTL2/GPI019	PD-50k
9	USB3DN TXDM1A	Z	59	VDD12	A/P
10	VDD12	A/P	60	AB0/ATTACHMUX0B/GPIO3	Z
11	USB3DN RXDP1A	Z	61	CC POL/GPI071	Z
12	USB3DN RXDM1A	Z	62	PRT_CTL6/GPI018	PD-50k
13	USB2DN DP6/ <u>PRT DIS P6</u>	PD-15k	63	ALT MUX EN/GPIO70	Z
14	USB2DN DM6/ <u>PRT DIS M6</u>	PD-15k	64	VDD33	A/P
15	USB3DN TXDP1B	Z	65	SPI CLK/GPIO4	Z
16	USB3DN TXDM1B	Z	66	SPI DO/GPI05	PD-50k
17	VDD12	A/P	67	SPI DI/GPIO9/CFG BC EN	Z
18	USB3DN RXDP1B	Z	68	SPI_CE_N/GPIO7/ <u>CFG_NON_REM</u>	PU-50k
19	USB3DN RXDM1B	Z	69	GPI069	Z
20	GPIO12/ <u>CFG_STRAP</u>	Z	70	PRT_CTL1/GPI017	
21	GPIO10	Z	71	GPIO66	Z
22	GPIO72	Z	72	VDD33	A/P
22	TESTEN	Z	72	C ATTACH1/ATTACHMUX1A/GPIO1	Z
23	VBUS DET/GPI016	Z	73	SMBDATA/GPIO6	Z
24	-	R	74		Z
25	RESET_N VDD12	A/P	75	SMBCLK/GPI08	Z
20	VDD12 VDD33	A/P	70	C_ATTACH0/ATTACHMUX0A/GPIO64 SUSP IND/GPIO68	Z
28	USB2DN DP2/ <u>PRT DIS P2</u>	PD-15k	78	VDD12	A/P
29	USB2DN_DM2/ <u>PRT_DIS_M2</u>	PD-15k Z	79	NC	PD-15k PD-15k
30	USB3DN_TXDP2		80	NC	-
31	USB3DN_TXDM2	Z	81	USB3UP_TXDPB	Z
32	VDD12	A/P	82	USB3UP_TXDMB	A/P
33	USB3DN_RXDP2	Z	83	VDD12	
34	USB3DN_RXDM2		84 85	USB3UP_RXDPB	Z
35 36	USB2DN_DP3/ <u>PRT_DIS_P3</u> USB2DN_DM3/PRT_DIS_M3	PD-15k PD-15k	85 86	USB3UP_RXDMB USB2DN_DP5/ <u>PRT_DIS_P5</u>	Z
					PD-15k
37	USB3DN_TXDP3	Z	87	USB2DN_DM5/ <u>PRT_DIS_M5</u>	PD-15k
38	USB3DN_TXDM3	Z	88	USB3DN_TXDP5	Z
39	VDD12	A/P	89	USB3DN_TXDM5	Z
40	USB3DN_RXDP3	Z	90	VDD12	A/P
41	USB3DN_RXDM3	Z	91	USB3DN_RXDP5	Z
42	VDD33	A/P	92	USB3DN_RXDM5	Z
43	USB2DN_DP4/ <u>PRT_DIS_P4</u>	PD-15k	93	VDD33	A/P
44	USB2DN_DM4/ <u>PRT_DIS_M4</u>	PD-15k	94	USB2UP_DP	PD-1M
45	USB3DN_TXDP4	Z	95	USB2UP_DM	PD-1M
46	USB3DN_TXDM4	Z	96	USB3UP_TXDPA	Z
47	VDD12	A/P	97	USB3UP_TXDMA	Z
48	USB3DN_RXDP4	Z	98	VDD12	A/P
49	USB3DN_RXDM4	Z	99	USB3UP_RXDPA	Z
50	AB1/ATTACHMUX1B/GPIO65	Z	100	USB3UP_RXDMA	Z

The pin reset state definitions are detailed in Table 3-1.

Symbol	Description			
A/P	Analog/Power Input			
R	Reset Control Input			
Z	Hardware disables output driver (high impedance)			
PU-50k	Hardware enables internal 50k $\Omega$ pull-up			
PD-50k	Hardware enables internal 50k $\Omega$ pull-down			
PD-15k	Hardware enables internal $15k\Omega$ pull-down			
PD-1M	Hardware enables internal 1M pull-down			

#### TABLE 3-1: PIN RESET STATE LEGEND

#### 3.3 USB5916 Pin Descriptions

This section contains descriptions of the various USB5916 pins. The pin descriptions have been broken into functional groups as follows:

- USB 3.1 Gen 1 Pin Descriptions
- USB 2.0 Pin Descriptions
- Port Control Pin Descriptions
- SPI Interface
- USB Type-C Connector Controls
- Miscellaneous Pin Descriptions
- Configuration Strap Pin Descriptions
- Power and Ground Pin Descriptions

The "\_N" symbol in the signal name indicates that the active, or asserted, state occurs when the signal is at a low voltage level. For example,  $RESET_N$  indicates that the reset signal is active low. When "\_N" is not present after the signal name, the signal is asserted when at the high voltage level.

The terms assertion and negation are used exclusively. This is done to avoid confusion when working with a mixture of "active low" and "active high" signal. The term assert, or assertion, indicates that a signal is active, independent of whether that level is represented by a high or low voltage. The term negate, or negation, indicates that a signal is inactive.

Name	Symbol	Buffer Type	Description
USB 3.1 Gen 1 Upstream A D+ TX	USB3UP_TXDPA	I/O-U	Upstream USB Type-C "Orientation A" USB 3.1 Gen 1 Transmit Data Plus
USB 3.1 Gen 1 Upstream A D- TX	USB3UP_TXDMA	I/O-U	Upstream USB Type-C "Orientation A" USB 3.1 Gen 1 Transmit Data Minus
USB 3.1 Gen 1 Upstream A D+ RX	USB3UP_RXDPA	I/O-U	Upstream USB Type-C "Orientation A" USB 3.1 Gen 1 Receive Data Plus

#### TABLE 3-2: USB 3.1 GEN 1 PIN DESCRIPTIONS

Name	Symbol	Buffer Type	Description
USB 3.1 Gen 1 Upstream A D- RX	USB3UP_RXDMA	I/O-U	Upstream USB Type-C "Orientation A" USB 3.1 Gen 1 Receive Data Minus
USB 3.1 Gen 1 Upstream B D+ TX	USB3UP_TXDPB	I/O-U	Upstream USB Type-C "Orientation B" USB 3.1 Gen 1 Transmit Data Plus
USB 3.1 Gen 1 Upstream B D- TX	USB3UP_TXDMB	I/O-U	Upstream USB Type-C "Orientation B" USB 3.1 Gen 1 Transmit Data Minus
USB 3.1 Gen 1 Upstream B D+ RX	USB3UP_RXDPB	I/O-U	Upstream USB Type-C "Orientation B" USB 3.1 Gen 1 Receive Data Plus
USB 3.1 Gen 1 Upstream B D- RX	USB3UP_RXDMB	I/O-U	Upstream USB Type-C "Orientation B" USB 3.1 Gen 1 Receive Data Minus
USB 3.1 Gen 1 Ports 5-2 D+ TX	USB3DN_TXDP[5:2]	I/O-U	Downstream Super Speed Transmit Data Plus, ports 5 through 2.
USB 3.1 Gen 1 Ports 5-2 D- TX	USB3DN_TXDM[5:2]	I/O-U	Downstream Super Speed Transmit Data Minus, ports 5 through 2.
USB 3.1 Gen 1 Ports 5-2 D+ RX	USB3DN_RXDP[5:2]	I/O-U	Downstream Super Speed Receive Data Plus, ports 5 through 2.
USB 3.1 Gen 1 Ports 5-2 D- RX	USB3DN_RXDM[5:2]	I/O-U	Downstream Super Speed Receive Data Minus, ports 5 through 2.
USB 3.1 Gen 1 Port 1 A D+ TX	USB3DN_TXDP1A	I/O-U	Downstream USB Type-C "Orientation A" Super Speed Transmit Data Plus, port 1.
USB 3.1 Gen 1 Port 1 A D- TX	USB3DN_TXDM1A	I/O-U	Downstream USB Type-C "Orientation A" Super Speed Transmit Data Minus, port 1.
USB 3.1 Gen 1 Port 1 A D+ RX	USB3DN_RXDP1A	I/O-U	Downstream USB Type-C "Orientation A" Super Speed Receive Data Plus, port 1.
USB 3.1 Gen 1 Port 1 A D- RX	USB3DN_RXDM1A	I/O-U	Downstream USB Type-C "Orientation A" Super Speed Receive Data Minus, port 1.
USB 3.1 Gen 1 Port 1 B D+ TX	USB3DN_TXDP1B	I/O-U	Downstream USB Type-C "Orientation B" Super Speed Transmit Data Plus, port 1.

TABLE 3-2: USB 3.1 GEN 1 PIN DESCRIPTIONS (CC	CONTINUED)
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Name	Symbol	Buffer Type	Description
USB 3.1 Gen 1 Port 1 B D- TX	USB3DN_TXDM1B	I/O-U	Downstream USB Type-C "Orientation B" Super Speed Transmit Data Minus, port 1.
USB 3.1 Gen 1 Port 1 B D+ RX	USB3DN_RXDP1B	I/O-U	Downstream USB Type-C "Orientation B" Super Speed Receive Data Plus, port 1.
USB 3.1 Gen 1 Port 1 B D- RX	USB3DN_RXDM1B	I/O-U	Downstream USB Type-C "Orientation B" Super Speed Receive Data Minus, port 1.

#### TABLE 3-3: USB 2.0 PIN DESCRIPTIONS

Name	Symbol	Buffer Type	Description
USB 2.0 Upstream D+	USB2UP_DP	I/O-U	Upstream USB 2.0 Data Plus (D+)
USB 2.0 Upstream D-	USB2UP_DM	I/O-U	Upstream USB 2.0 Data Minus (D-)
USB 2.0 Ports 6 D+	USB2DN_DP[6:1]	I/O-U	Downstream USB 2.0 Ports 6-1 Data Plus (D+)
USB 2.0 Ports 6 D-	USB2DN_DM[6:1]	I/O-U	Downstream USB 2.0 Ports 6-1 Data Minus (D-)
VBUS Detect	VBUS_DET	IS	This signal detects the state of the upstream bus power. When designing a detachable hub, this pin must be con- nected to the VBUS power pin of the upstream USB port through a resistor divider ( $50 \text{ k}\Omega$ by $100 \text{ k}\Omega$ ) to provide 3.3  V. For self-powered applications with a permanently attached host, this pin must be connected to either $3.3 \text{ V}$ or $5.0 \text{ V}$ through a resistor divider to provide $3.3 \text{ V}$ . In embedded applications, <b>VBUS_DET</b> may be controlled (toggled) when the host desires to renegotiate a connec- tion without requiring a full reset of the device.

Name	Symbol	Buffer Type	Description
Port 6 Power Enable / Overcurrent Sense	PRT_CTL6	I/OD12 (PU)	Port 6 Power Enable / Overcurrent Sense. When the downstream port is enabled, this pin is set as an input with an internal pull-up resistor applied. The internal pull-up enables power to the downstream port while the pin monitors for an active low overcurrent signal assertion from an external current monitor on USB port 6. This pin will change to an output and be driven low when the port is disabled by configuration or by the host con- trol.
Port 5 Power Enable / Overcurrent Sense	PRT_CTL5	I/OD12 (PU)	Port 5 Power Enable / Overcurrent Sense. When the downstream port is enabled, this pin is set as an input with an internal pull-up resistor applied. The internal pull-up enables power to the downstream port while the pin monitors for an active low overcurrent signal assertion from an external current monitor on USB port 5. This pin will change to an output and be driven low when the port is disabled by configuration or by the host con- trol.
Port 4 Power Enable / Overcurrent Sense	PRT_CTL4	I/OD12 (PU)	Port 4 Power Enable / Overcurrent Sense. When the downstream port is enabled, this pin is set as an input with an internal pull-up resistor applied. The internal pull-up enables power to the downstream port while the pin monitors for an active low overcurrent signal assertion from an external current monitor on USB port 4. This pin will change to an output and be driven low when the port is disabled by configuration or by the host con- trol.
Port 3 Power Enable / Overcurrent Sense	PRT_CTL3	I/OD12 (PU)	Port 3 Power Enable / Overcurrent Sense. When the downstream port is enabled, this pin is set as an input with an internal pull-up resistor applied. The internal pull-up enables power to the downstream port while the pin monitors for an active low overcurrent signal assertion from an external current monitor on USB port 3. This pin will change to an output and be driven low when the port is disabled by configuration or by the host con- trol.

TABLE 3-4:	PORT CONTROL PIN DESCRIPTIONS
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#### TABLE 3-4: PORT CONTROL PIN DESCRIPTIONS (CONTINUED)

Name	Symbol	Buffer Type	Description
Port 2 Power Enable / Overcurrent Sense	PRT_CTL2	I/OD12 (PU)	Port 2 Power Enable / Overcurrent Sense. When the downstream port is enabled, this pin is set as an input with an internal pull-up resistor applied. The internal pull-up enables power to the downstream port while the pin monitors for an active low overcurrent signal assertion from an external current monitor on USB port 2. This pin will change to an output and be driven low when the port is disabled by configuration or by the host con- trol.
Port 1 Power Enable / Overcurrent Sense	PRT_CTL1	I/OD12 (PU)	Port 1 Power Enable / Overcurrent Sense. When the downstream port is enabled, this pin is set as an input with an internal pull-up resistor applied. The internal pull-up enables power to the downstream port while the pin monitors for an active low overcurrent signal assertion from an external current monitor on USB port 1. This pin will change to an output and be driven low when the port is disabled by configuration or by the host con- trol.
Gang Power	GANG_PWR	I	<b>GANG_PWR</b> becomes the port control (PRTCTL) pin for all downstream ports when the hub is configured for ganged port power control mode. All port power control- lers should be controlled from this pin when the hub is configured for ganged port power mode.

#### TABLE 3-5: SPI INTERFACE

Name	Symbol	Buffer Type	Description
SPI Chip Enable	SPI_CE_N	I/O12	This is the active low SPI chip enable output. If the SPI interface is enabled, this pin must be driven high in power-down states.
SPI Clock	SPI_CLK	I/O-U	This is the SPI clock out to the serial ROM. If the SPI interface is disabled, by setting the SPI_DIS-ABLE bit in the UTIL_CONFIG1 register, this pin becomes <b>GPIO4</b> . If the SPI interface is enabled this pin must be driven low during reset.
SPI Data Output	SPI_DO	I/O-U	SPI data output, when configured for SPI operation.
SPI Data Input	SPI_DI	I/O-U	SPI data input, when configured for SPI operation.

**Note:** If SPI memory device is not used, these pins may not be simply floated. These pins must be handled per their respective alternate pin functions descriptions (CFG\_BC\_EN and CFG\_NON\_REM).

Name	Symbol	Buffer Type	Description
USB Type-C Attach Control Input 0-2	C_ATTACH[0:2]	l (PD)	"Type-C Control Mode 1" USB Type-C attach control input.
input 0-2			This pin indicates to the hub when a valid USB Type-C attach has been detected. This pin is used by the hub to enable the USB 3.1 Gen 1 PHY when a Type-C connection is present. When there is no USB Type-C connection present, the USB 3.1 Gen 1 PHY is disabled to reduce power consumption.
			The polarity of this input is controlled via the CC_POL pin. If CC_POL is low, this pin behaves as follows:
			<ul> <li>1: USB Type-C attach detected, turn respective USB 3.1 Gen 1 PHY on.</li> </ul>
			<ul> <li>0: No USB Type-C attach detected, turn respec- tive USB 3.1 Gen 1 PHY off.</li> </ul>
			If CC_POL is high, this pin behaves as follows:
			<ul> <li>1: No USB Type-C attach detected, turn respec- tive USB3.1 Gen 1 PHY off.</li> </ul>
			<ul> <li>0: USB Type-C attach detected, turn respective USB3.1 Gen 1 PHY on.</li> </ul>
			When using legacy USB Type-A and Type-B connectors, pull these pins to 3.3V to permanently enable all USB 3.1 PHYs.
USB Type-C Orientation	AB[0:1]	l (PD)	"Type-C Control Mode 1" USB Type-C orientation control input.
Control Input 0-1			This pin signals to the hub the orientation of the USB Type-C connector. The hub enables the appropriate USB 3.1 Gen 1 PHY based upon the polarity of this signal, and the assertion of the associated $C_ATTACH[0:2]$ pin.
			The polarity of this input is controlled via the CC_POL pin. If CC_POL is low, this pin behaves as follows:
			<ul><li>- 1: Enable USB 3.1 Gen 1 PHY B.</li><li>- 0: Enable USB 3.1 Gen 1 PHY A.</li></ul>
			If CC_POL is high, this pin behaves as follows: - 1: Enable USB 3.1 Gen 1 PHY A.
			- 0: Enable USB 3.1 Gen 1 PHY B.

#### TABLE 3-6: USB TYPE-C CONNECTOR CONTROLS

# TABLE 3-6: USB TYPE-C CONNECTOR CONTROLS (CONTINUED)

Name	Symbol	Buffer Type	Description
USB Type-C Alternative Orientation A Attach 0-1	ATTACH_MUX[0:1]A	I (PD)	<ul> <li>"Type-C Control Mode 2" Alternative USB Type-C attach for "Orientation A" USB Type-C connections.</li> <li>This mode of control is an alternative to the C_AT- TACH[0:2] and AB[0:1] pins. To select this mode, the ALT_MUX_EN pin must be high.</li> <li>When this pin asserted, the hub enables the "Orientation A" USB 3.1 Gen 1 PHY of the associated port. When there is no USB Type-C connection present and this pin is not asserted, the associated USB 3.1 Gen 1 PHY is disabled to reduce power consumption.</li> <li>The polarity of this input is controlled via the CC_POL pin.</li> <li>If CC_POL is low, this pin behaves as follows: <ul> <li>1: USB Type-C attach detected, turn respective "Orientation A" USB 3.1 Gen 1 PHY on.</li> <li>0: No USB Type-C attach detected, turn respec- tive "Orientation A" USB 3.1 Gen 1 PHY off.</li> </ul> </li> <li>If CC_POL is high, this pin behaves as follows: <ul> <li>1: No USB Type-C attach detected, turn respec- tive "Orientation A" USB 3.1 Gen 1 PHY off.</li> </ul> </li> <li>If CC_POL is high, this pin behaves as follows: <ul> <li>0: No USB Type-C attach detected, turn respec- tive "Orientation A" USB 3.1 Gen 1 PHY off.</li> </ul> </li> </ul>

TABLE 3-6: USB TYPE-C CONNECTOR CONTROLS (CONTINUED)
--

Name	Symbol	Buffer Type	Description
USB Type-C Alternative Orientation B Attach 0-1	ATTACH_MUX[0:1]B	l (PD)	<ul> <li>"Type-C Control Mode 2" USB Type-C attach for "Orientation B" USB Type-C connections.</li> <li>This mode of control is an alternative to the C_AT-TACH[0:2] and AB[0:1] pins. To select this mode, the ALT_MUX_EN pin must be high.</li> <li>When this pin asserted, the hub enables the "Orientation B" USB 3.1 Gen 1 PHY of the associated port. When there is no USB Type-C connection present and this pin is not asserted, the associated USB 3.1 Gen 1 PHY is disabled to reduce power consumption.</li> <li>The polarity of this input is controlled via the CC_POL pin.</li> <li>If CC_POL is low, this pin behaves as follows: <ul> <li>1: USB Type-C attach detected, turn respective "Orientation B" USB 3.1 Gen 1 PHY on.</li> <li>0: No USB Type-C attach detected, turn respective "Orientation B" USB 3.1 Gen 1 PHY off.</li> </ul> </li> <li>If CC_POL is high, this pin behaves as follows: <ul> <li>1: No USB Type-C attach detected, turn respective "Orientation B" USB 3.1 Gen 1 PHY off.</li> </ul> </li> </ul>
Attach Polarity Control	CC_POL	I (PD)	USB C_ATTACH polarity control input. If this pin is low, the C_ATTACH[0:2], AB[0:1], ATTACH_MUX[0:1]A, and ATTACH_MUX[0:1]B pins are active high. If this pin is high, the C_ATTACH[0:2], AB[0:1], ATTACH_MUX[0:1]A, and ATTACH_MUX[0:1]B pins are active low. This pin has an internal pull-down enabled. If the desired strapping is to pull this pin low, then this pin may be left unconnected.

# TABLE 3-6: USB TYPE-C CONNECTOR CONTROLS (CONTINUED)

Name	Symbol	Buffer Type	Description
USB Type-C Control Mode Selection	ALT_MUX_EN	l (PD)	USB Type-C control mode selection. If this pin is low, the hub operates in "Type-C Control Mode 1". In "Type-C Control Mode 1", the C_AT- TACH[0:2] and AB[0:1] pin functions are used. If this pin is high, the hub operates in "Type-C Control Mode 2". In "Type-C Control Mode 2", the ATTACH_MUX[0:1]A and ATTACH_MUX[0:1]B pin functions are used. This pin has an internal pull-down enabled. If the desired mode is "Type-C Control Mode 1", then this pin may be left unconnected.

#### TABLE 3-7: MISCELLANEOUS PIN DESCRIPTIONS

Name	Symbol	Buffer Type	Description
SMBus/I <sup>2</sup> C Clock	SMBCLK	I/O12	SMBus/I <sup>2</sup> C Clock The SMBus/I <sup>2</sup> C interface acts as SMBus slave or I <sup>2</sup> C bridge dependent on the device configuration.
			For information on how to configure this interface refer to Section 3.5.1, CFG_STRAP Configuration.
SMBus/I <sup>2</sup> C Data	SMBDATA	I/O12	SMBus/I <sup>2</sup> C Data
			The SMBus/ $I^2$ C interface acts as SMBus slave or $I^2$ C bridge dependent on the device configuration.
			For information on how to configure this interface refer to Section 3.5.1, CFG_STRAP Configuration.
USB Host Port 1-0 Speed Indicator	HOST_TYPE_[1:0]	O12	USB Host Port Speed Indicator
Speed indicator			Tri-state: Not connected
			0: USB 3.1 Gen 1 1: USB 2.0 / USB 1.1
General Purpose I/O	GPIO[1:10], GPIO12,	I/O12 (PU/	General Purpose Inputs/Outputs
	GPIO[16:23], GPIO[64:72]	PD)	Refer to Section 3.5.5, General Purpose input/Output Configuration (GPIOx) for details.
USB 2.0 Suspend State	SUSP_IND	O12	USB 2.0 Suspend State Indicator
Indicator			SUSP_IND can be used as a sideband remote wakeup signal for the host when in USB 2.0 suspend.

# TABLE 3-7: MISCELLANEOUS PIN DESCRIPTIONS (CONTINUED)

Name	Symbol	Buffer Type	Description
Reset Control Input	RESET_N	IS	Reset Control Input
mpar			This pin places the hub into Reset Mode when pulled low.
Bias Resistor	RBIAS	I-R	A 12.0 k $\Omega$ (+/- 1%) resistor is attached from ground to this pin to set the transceiver's internal bias settings. Place the resistor as close to the device as possible with a dedicated, low impedance connection to the GND plane.
External 25 MHz Crystal Input	XTALI	ICLK	External 25 MHz crystal input
External 25 MHz Reference Clock Input	CLKIN	ICLK	External reference clock input. The device may alternatively be driven by a single-ended clock oscillator. When this method is used, <b>XTALO</b> should be left unconnected.
External 25 MHz Crystal Output	XTALO	OCLK	External 25 MHz crystal output
Test	TESTEN	I/O12	Test pin.
			This signal is used for test purposes and must always be connected to ground.
No Connect	NC	-	No connect.
			For proper operation, this signal must be left uncon- nected.

#### TABLE 3-8: CONFIGURATION STRAP PIN DESCRIPTIONS

Name	Symbol	Buffer Type	Description
Device Mode Configuration Strap	<u>CFG_STRAP</u>	I	Device Mode Configuration Strap. This configuration strap is used to set the device mode. Refer to Section 3.5.1, CFG_STRAP Configuration for details. See Note 2
Port 6-1 D+ Disable Configuration Strap	<u>PRT_DIS_P[6:1]</u>	I	Port 6-1 D+ Disable Configuration Strap. These configuration straps are used in conjunction with the corresponding PRT_DIS_M[6:1] straps to disable the related port (6-1). Refer to Section Section 3.5.2, Port Disable Configuration (PRT_DIS_P[6:1] / PRT_DIS_M[6:1]) for more information. See Note 2
Port 6-1 D- Disable Configuration Strap	<u>PRT_DIS_M[6:1]</u>	Ι	Port 6-1 D- Disable Configuration Strap. These configuration straps are used in conjunction with the corresponding <u>PRT_DIS_P[6:1]</u> straps to disable the related port (6-1). Refer to Section 3.5.2, Port Disable Configuration (PRT_DIS_P[6:1] / PRT_DIS_M[6:1]) for more information. See Note 2
Non-Removable Ports Configuration Strap	<u>CFG_NON_REM</u>	I	Configuration strap to control number of reported non- removal ports. See Section 3.5.3, Non-Removable Port Configuration (CFG_NON_REM) See Note 2
Battery Charging Configuration Strap	<u>CFG_BC_EN</u>	I	Configuration strap to control number of BC 1.2 enabled downstream ports. See Section 3.5.4, Battery Charging Configuration (CFG_BC_EN) See Note 2

**Note 2:**Configuration strap values are latched on Power-On Reset (POR) and the rising edge of **RESET\_N** (external chip reset). Configuration straps are identified by an underlined symbol name. Signals that function as configuration straps must be augmented with an external resistor when connected to a load. Refer to Section 3.5, Configuration Straps and Programmable Functions for additional information.

TABLE 3-9:	POWER AND GROUND PIN DESCRIPTIONS

Name	Symbol	Buffer Type	Description
+3.3V Power	VDD33	Р	+3.3 V power and internal regulator input
Supply Input			Refer to Section 4.1, Power Connections for power con- nection information
+1.2V Core	VDD12	Р	+1.2 V core power
Power Supply Input			Refer to Section 4.1, Power Connections for power con- nection information.
Ground	GND	Р	Common ground.
			This exposed pad must be connected to the ground plane with a via array.

# 3.4 Buffer Type Descriptions

#### TABLE 3-10: USB5916 BUFFER TYPE DESCRIPTIONS

BUFFER	DESCRIPTION
I	Input.
IS	Input with Schmitt trigger.
012	Output buffer with 12 mA sink and 12 mA source.
OD12	Open-drain output with 12 mA sink
PU	50 $\mu\text{A}$ (typical) internal pull-up. Unless otherwise noted in the pin description, internal pull-ups are always enabled.
	Internal pull-up resistors prevent unconnected inputs from floating. Do not rely on internal resistors to drive signals external to the device. When connected to a load that must be pulled high, an external resistor must be added.
PD	50 μA (typical) internal pull-down. Unless otherwise noted in the pin description, internal pull-downs are always enabled.
	Internal pull-down resistors prevent unconnected inputs from floating. Do not rely on internal resistors to drive signals external to the device. When connected to a load that must be pulled low, an external resistor must be added.
ICLK	Crystal oscillator input pin
OCLK	Crystal oscillator output pin
I/O-U	Analog input/output defined in USB specification.
I-R	RBIAS.

Note: Refer to Section 9.5, DC Specifications for individual buffer DC electrical characteristics.

#### 3.5 Configuration Straps and Programmable Functions

Configuration straps are multi-function pins that are used during Power-On Reset (POR) or external chip reset (RESET\_N) to determine the default configuration of a particular feature. The state of the signal is latched following deassertion of the reset. Configuration straps are identified by an underlined symbol name. This section details the various device configuration straps and associated programmable pin functions.

**Note:** The system designer must guarantee that configuration straps meet the timing requirements specified in Section 9.6.2, Power-On and Configuration Strap Timing and Section 9.6.3, Reset and Configuration Strap Timing. If configuration straps are not at the correct voltage level prior to being latched, the device may capture incorrect strap values.

#### 3.5.1 <u>CFG\_STRAP</u> CONFIGURATION

The <u>CFG\_STRAP</u> pin is used to place the hub into preset modes of operation. The resistor options are a 200 k $\Omega$  pull-down, 200 k $\Omega$  pull-up, 10 k $\Omega$  pull-down, 10 k $\Omega$  pull-up, 10  $\Omega$  pull-down, and 10  $\Omega$  pull-up as shown in Table 3-11.

<u>CFG_STRAP</u> Resistor Value	Config	Setting
200 kΩ Pull-Down	CONFIG1	I <sup>2</sup> C Bridging Mode
		The SMBus interface will operate in Master Mode for use with USB to $I^2C$ bridging function. For more information on USB to $I^2C$ bridging with the USB5806, refer to the "USB to $I^2C$ Using Microchip USB 3.1 Gen 1 Hubs" application note.
200 kΩ Pull-Up	CONFIG2	SMBus Slave Mode
		The SMBus interface will operate in Slave Mode for use with hub configuration.
10 kΩ Pull-Down	CONFIG3	Unused, Reserved
10 kΩ Pull-Up	CONFIG4	Unused, Reserved
10 Ω Pull-Down	CONFIG5	Unused, Reserved
10 Ω Pull-Up	CONFIG6	Unused, Reserved

TABLE 3-11: CFG\_STRAP RESISTOR ENCODING

#### 3.5.2 PORT DISABLE CONFIGURATION (<u>PRT\_DIS\_P[6:1]</u> / <u>PRT\_DIS\_M[6:1]</u>)

The <u>PRT\_DIS\_P[6:1]</u> and <u>PRT\_DIS\_M[6:1]</u> configuration straps are used in conjunction to disable the related port (6-1).

For <u>**PRT\_DIS\_P**x</u> (where *x* is the corresponding port 6-1):

- **0** = Port *x* D+ Enabled
- **1** = Port x D+ Disabled

For <u>**PRT\_DIS\_M**</u> (where *x* is the corresponding port 6-1):

0 = Port x D- Enabled

1 = Port x D- Disabled

**Note:** Both <u>PRT\_DIS\_Px</u> and <u>PRT\_DIS\_Mx</u> (where *x* is the corresponding port) must be tied to 3.3 V to disable the associated downstream port. Disabling the USB 2.0 port will also disable the corresponding USB 3.1 Gen 1 port.

#### 3.5.3 NON-REMOVABLE PORT CONFIGURATION (CFG\_NON\_REM)

The <u>CFG\_NON\_REM</u> configuration strap is used to configure the non-removable port settings of the device to one of five settings. These modes are selected by the configuration of an external resistor on the <u>CFG\_NON\_REM</u> pin. The resistor options are a 200 k $\Omega$  pull-down, 200 k $\Omega$  pull-up, 10 k $\Omega$  pull-down, 10 k $\Omega$  pull-up, 10  $\Omega$  pull-down and 10  $\Omega$  pull-up as shown in Table 3-12.

#### TABLE 3-12: CFG\_NON\_REM RESISTOR ENCODING

<u>CFG_NON_REM</u> Resistor Value	Setting
200 kΩ Pull-Down	All ports removable
200 kΩ Pull-Up	Port 2 non-removable
10 kΩ Pull-Down	Port 2, 3 non-removable
10 kΩ Pull-Up	Port 2, 3, 4, non-removable
10 Ω Pull-Down	Port 2, 3, 4, 5 non-removable
10 Ω Pull-Up	Port 2, 3, 4, 5, 6 non-removable

#### 3.5.4 BATTERY CHARGING CONFIGURATION (<u>CFG\_BC\_EN</u>)

The <u>CFG\_BC\_EN</u> configuration strap is used to configure the battery charging port settings of the device to one of five settings. These modes are selected by the configuration of an external resistor on the <u>CFG\_BC\_EN</u> pin. The resistor options are a 200 k $\Omega$  pull-down, 200 k $\Omega$  pull-up, 10 k $\Omega$  pull-down, 10 k $\Omega$  pull-up, 10  $\Omega$  pull-down and 10  $\Omega$  pull-up as shown in Table 3-13.

#### TABLE 3-13: CFG\_BC\_EN RESISTOR ENCODING

CFG_BC_EN Resistor Value	Setting	
200 kΩ Pull-Down	No battery charging	
200 kΩ Pull-Up	Port 1 battery charging	
10 kΩ Pull-Down	Port 1, 2 battery charging	
10 kΩ Pull-Up	Port 1, 2, 3, battery charging	
10 Ω Pull-Down	Port 1, 2, 3, 4 battery charging	
10 Ω Pull-Up	Port 1, 2, 3, 4, 5, 6 battery charging	

#### 3.5.5 GENERAL PURPOSE INPUT/OUTPUT CONFIGURATION (GPIOx)

General Purpose Inputs/Outputs may be used for application specific purposes. Any given GPIO may operate as an input or an output. Inputs can apply an internal  $50k\Omega$  pull-down or pull-up resistor. Outputs may drive low or drive high (3.3V). GPIOs may be configured and manipulated during runtime (while enumerated to a host) in one of two ways:

- SMBus configuration
- USB to GPIO bridging

#### 3.5.5.1 SMBus configuration

The SMBus slave interface may be used to write to internal registers that configure the state of the GPIO. Refer to the "Configuration Options for Microchip USB58xx and USB59xx Hubs" application note for additional details.

#### 3.5.5.2 USB to GPIO Bridging

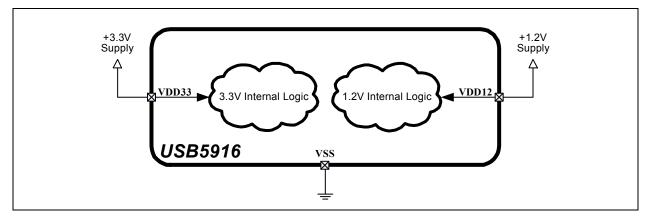
USB to GPIO Bridging may be used to write to internal registers that configure the state of the GPIO. USB to GPIO bridging operates via host communication to the hub's internal Hub Feature Controller. Refer to the "USB to GPIO Bridging for Microchip USB3.1 Gen 1 Hubs" application note for additional details.

# 4.0 DEVICE CONNECTIONS

#### 4.1 Power Connections

Figure 4-1 illustrates the device power connections.

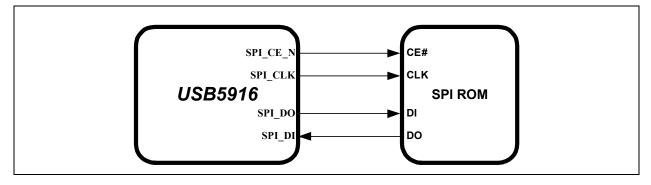
#### FIGURE 4-1: DEVICE POWER CONNECTIONS



#### 4.2 SPI ROM Connections

Figure 4-2 illustrates the device SPI ROM connections. Refer to **Section 7.1 "SPI Master Interface"** for additional information on this device interface.

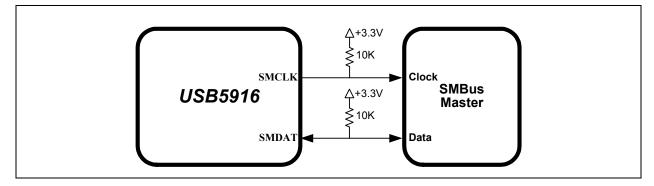




#### 4.3 SMBus Slave Connections

Figure 4-3 illustrates the device SMBus slave connections. Refer to **Section 7.2** "**SMBus Slave Interface**" for additional information on this device interface.

#### FIGURE 4-3: SMBUS SLAVE CONNECTIONS



# 5.0 MODES OF OPERATION

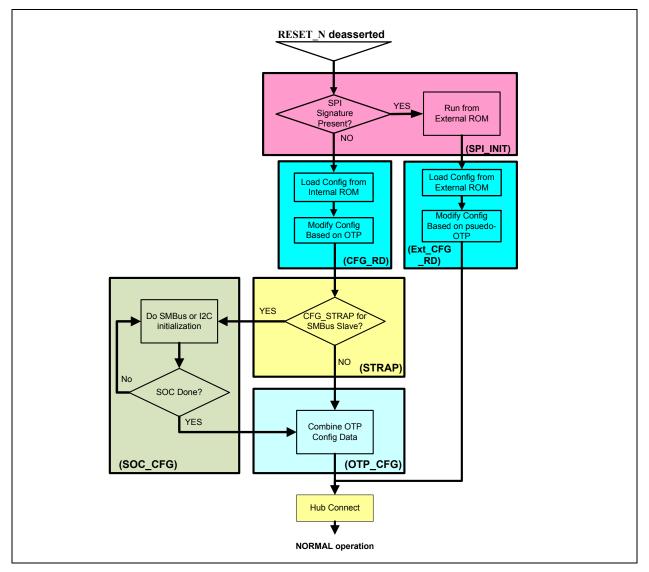
The device provides two main modes of operation: Standby Mode and Hub Mode. These modes are controlled via the **RESET\_N** pin, as shown in Table 5-1.

#### TABLE 5-1:MODES OF OPERATION

RESET_N Input	Summary	
0	<b>Standby Mode</b> : This is the lowest power mode of the device. No functions are active other than monitoring the RESET_N input. All port interfaces are high impedance and the PLL is halted. Refer to Section 8.3.2, External Chip Reset (RESET_N) for additional information on RESET_N.	
1	<b>Hub (Normal) Mode</b> : The device operates as a configurable USB hub with battery charger detection. This mode has various sub-modes of operation, as detailed in Figure 5-1. Power consumption is based on the number of active ports, their speed, and amount of data transferred.	

The flowchart in Figure 5-1 details the modes of operation and how the device traverses through the Hub Mode stages (shown in bold). The remaining sub-sections provide more detail on each stage of operation.

#### FIGURE 5-1: HUB BOOT FLOWCHART



#### 5.1 Standby Mode

If the **RESET\_N** pin is asserted, the hub will be in Standby Mode. This mode provides a very low power state for maximum power efficiency when no signaling is required. This is the lowest power state. In Standby Mode all downstream ports are disabled, the USB data pins are held in a high-impedance state, all transactions immediately terminate (no states saved), all internal registers return to their default state, the PLL is halted, and core logic is powered down in order to minimize power consumption. Because core logic is powered off, no configuration settings are retained in this mode and must be re-initialized after **RESET\_N** is negated high.

# 5.2 SPI Initialization Stage (SPI\_INIT)

The first stage, the initialization stage, occurs on the deassertion of **RESET\_N**. In this stage, the internal logic is reset, the PLL locks if a valid clock is supplied, and the configuration registers are initialized to their default state. The internal firmware then checks for an external SPI ROM. The firmware looks for an external SPI flash device that contains a valid signature of "2DFU" (device firmware upgrade) beginning at address 0xFFFA. If a valid signature is found, then the external ROM is enabled and the code execution begins at address 0x0000 in the external SPI device. If a valid signature is not found, then execution continues from internal ROM (CFG\_RD stage).

When using an external SPI ROM, a 1 Mbit, 60 MHz or faster ROM must be used. Both 1- and 2-bit SPI operation are supported. For optimum throughput, a 2-bit SPI ROM is recommended. Both mode 0 and mode 3 SPI ROMs are also supported.

If the system is not strapped for SPI Mode, code execution will continue from internal ROM (CFG\_RD stage).

# 5.3 Configuration Read Stage (CFG\_RD)

In this stage, the internal firmware loads the default values from the internal ROM and then uses the configuration strapping options to override the default values. Refer to Section 3.5, Configuration Straps and Programmable Functions for information on usage of the various device configuration straps.

#### 5.4 Strap Read Stage (STRAP)

In this stage, the firmware registers the configuration strap settings and checks the state of <u>CFG\_STRAP</u>. If <u>CFG\_STRAP</u> is set for CONFIG2, then the hub will check the state of the <u>SMBDATA</u> and <u>SMBCLK</u> pins. If 10k pull-up resistors are detected on both pins, the device will enter the SOC\_CFG stage. If 10k pull-up resistors are not detected on both pins, the hub will transition to the OTP\_CFG stage instead.

# 5.5 SOC Configuration Stage (SOC\_CFG)

In this stage, the SOC can modify any of the default configuration settings specified in the integrated ROM, such as USB device descriptors and port electrical settings.

There is no time limit on this mode. In this stage the firmware will wait indefinitely for the SMBus/I<sup>2</sup>C configuration. When the SOC has completed configuring the device, it must write to register 0xFF to end the configuration.

#### 5.6 OTP Configuration Stage (OTP\_CFG)

Once the SOC has indicated that it is done with configuration, all configuration data is combined in this stage. The default data, the SOC configuration data, and the OTP data are all combined in the firmware and the device is programmed.

After the device is fully configured, it will go idle and then into suspend if there is no VBUS or Hub.Connect present. Once VBUS is present, and battery charging is enabled, the device will transition to the Battery Charger Detection Stage. If VBUS is present, and battery charging is not enabled, the device will transition to the Connect stage.

#### 5.7 Hub Connect Stage (Hub.Connect)

Once the CHGDET stage is completed, the device enters the Hub Connect stage. USB connect can be initiated by asserting the VBUS pin function high. The device will remain in the Hub Connect stage indefinitely until the VBUS pin function is deasserted.

#### 5.8 Normal Mode

Lastly, the hub enters Normal Mode of operation. In this stage full USB operation is supported under control of the USB Host on the upstream port. The device will remain in the normal mode until the operating mode is changed by the system.

# 6.0 DEVICE CONFIGURATION

The device supports a large number of features (some mutually exclusive), and must be configured in order to correctly function when attached to a USB host controller. The hub can be configured either internally or externally depending on the implemented interface.

Microchip provides a comprehensive software programming tool, Pro-Touch2, for configuring the USB5916 functions, registers and OTP memory. All configuration is to be performed via the Pro-Touch2 programming tool. For additional information on the Pro-Touch2 programming tool, refer to Software Libraries within Microchip USB5916 product page at www.microchip.com/USB5916.

**Note:** Device configuration straps and programmable pins are detailed in Section 3.5, Configuration Straps and Programmable Functions. Refer to Section 7.0, Device Interfaces for detailed information on each device interface.

#### 6.1 Customer Accessible Functions

The following functions are available to the customer via the Pro-Touch2 Programming Tool.

Note: For additional programming details, refer to the Pro-Touch2 programming tool User's Guide.

#### 6.1.1 USB ACCESSIBLE FUNCTIONS

#### 6.1.1.1 I<sup>2</sup>C Bridging Access over USB

Access to I<sup>2</sup>C devices is performed as a pass-through operation from the USB Host. The device firmware has no knowledge of the operation of the attached I<sup>2</sup>C device. For more information, refer to the Microchip USB5916 product page and Pro-Touch2 at www.microchip.com/USB5916.

**Note:** Refer to Section 7.3, I2C Bridge Interface for additional information on the I<sup>2</sup>C interface.

#### 6.1.1.2 SPI Access over USB

Access to an attached SPI device is performed as a pass-through operation from the USB Host. The device firmware has no knowledge of the operation of the attached SPI device. For more information, refer to the Microchip USB5916 product page and SDK at www.microchip.com/USB5916.

Note: Refer to Section 7.1, SPI Master Interface for additional information on the SPI.

#### 6.1.1.3 OTP Access

The OTP ROM in the device is accessible via the USB bus during normal runtime operation or SMBus during the SOC\_CFG stage. For more information, refer to the Microchip USB5916product page or the Pro-Touch2 User's Guide.

#### 6.1.1.4 Battery Charging Access over USB

The Battery charging behavior of the device can be dynamically changed by the USB Host when something other than the preprogrammed or OTP programmed behavior is desired. For more information, refer to the Microchip USB5916product page or the Pro-Touch2 User's Guide.

#### 6.1.2 SMBUS ACCESSIBLE FUNCTIONS

OTP access and configuration of specific device functions are possible via the USB5916 SMBus slave interface. All OTP parameters can be modified via the SMBus Host. For more information refer to the Microchip USB5916 product page.

# 7.0 DEVICE INTERFACES

The USB5916 provides multiple interfaces for configuration and external memory access. This section details the various device interfaces and their usage:

- SPI Master Interface
- SMBus Slave Interface
- I2C Bridge Interface

Note: For details on how to enable each interface, refer to Section 3.5, Configuration Straps and Programmable Functions.
 For information on device connections, refer to Section 4.0, Device Connections. For information on device configuration, refer to Section 6.0, Device Configuration.
 Microchip provides a comprehensive software programming tool, Pro-Touch2, for configuring the USB5916 functions, registers and OTP memory. All configuration is to be performed via the Pro-Touch2 programming tool. For additional information on the Pro-Touch2 programming tool, refer to Software Libraries within Microchip USB5916 product page at www.microchip.com/USB5916.

#### 7.1 SPI Master Interface

The device is capable of code execution from an external SPI ROM. When configured for SPI Mode, on power up the firmware looks for an external SPI flash device that contains a valid signature of 2DFU (device firmware upgrade) beginning at address 0xFFFA. If a valid signature is found, then the external ROM is enabled and the code execution begins at address 0x0000 in the external SPI device. If a valid signature is not found, then execution continues from internal ROM.

**Note:** For SPI timing information, refer to Section 9.6.7, SPI Timing.

#### 7.2 SMBus Slave Interface

The device includes an integrated SMBus slave interface, which can be used to access internal device run time registers or program the internal OTP memory. SMBus slave detection is accomplished by setting the <u>CFG\_STRAP</u> in the correct configuration followed by detection of pull-up resistors on both the <u>SMDAT</u> and <u>SMCLK</u> signals during the hub's boot-up sequence. Refer to <u>Section 3.5.1</u>, <u>CFG\_STRAP</u> Configuration for additional information.

**Note:** All configuration is to be performed via the Pro-Touch2 programming tool. For additional information on the Pro-Touch2 programming tool, refer to Software Libraries within Microchip USB5916 product page at www.microchip.com/USB5916.

# 7.3 I<sup>2</sup>C Bridge Interface

The I<sup>2</sup>C Bridge interface implements a subset of the I<sup>2</sup>C Master Specification (Please refer to the *Philips Semiconductor Standard I<sup>2</sup>C-Bus Specification* for details on I<sup>2</sup>C bus protocols). The I<sup>2</sup>C Bridge conforms to the Fast-Mode I<sup>2</sup>C Specification (400 kbit/s transfer rate and 7-bit addressing) for protocol and electrical compatibility. The device acts as the master and generates the serial clock SCL, controls the bus access (determines which device acts as the transmitter and which device acts as the receiver), and generates the START and STOP conditions. The I<sup>2</sup>C Bridge interface frequency is configurable through the I<sup>2</sup>C Bridging commands. I<sup>2</sup>C Bridge frequencies are derived from the formula 626KHz/n, where n is any integer from 1 to 256. Refer to Section 3.5.1, CFG\_STRAP Configuration for additional information.

**Note:** Extensions to the I<sup>2</sup>C Specification are not supported. All configuration is to be performed via the Pro-Touch2 programming tool. For additional information on the Pro-Touch2 programming tool, refer to Software Libraries within Microchip USB5916 product page at www.microchip.com/USB5916.

# 8.0 FUNCTIONAL DESCRIPTIONS

This section details various USB5916 functions, including:

- USB Type-C Receptacle Support
- Battery Charging
- Resets
- Link Power Management (LPM)
- Remote Wakeup Indicator
- Port Control Interface
- Port Split
- •

#### 8.1 USB Type-C Receptacle Support

The USB5916 has built-in support for the USB Type-C receptacle. There are 3 fundamental configurations:

- External USB 3.1 Gen 1 Multiplexer
- Internal USB3.1 Gen 1 Multiplexer, "Type-C Control Mode 1"
- Internal USB 3.1 Gen 1 Multiplexer, "Type-C Control Mode 2"

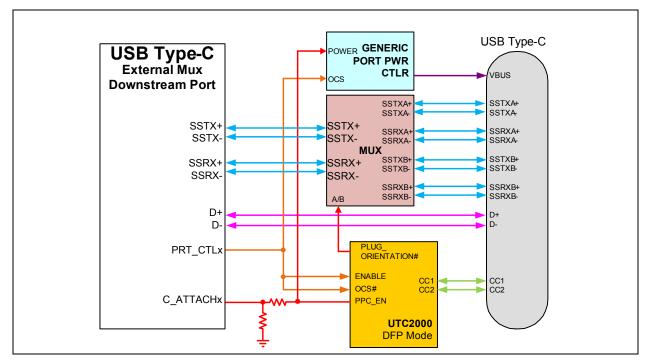
#### 8.1.1 EXTERNAL USB 3.1 GEN 1 MULTIPLEXER

C\_ATTACH[0:2] pins are used to signal to the hub when a valid USB Type-C connection has been detected. This functionality requires an external USB Type-C controller such as a Microchip UTC2000 to monitor the USB Type-C receptacle for a valid attach. This signal is used to enable and disable clocking to the USB 3.1 Gen 1 PHY in order to reduce power consumption when there is no USB Type-C attach.

The polarity of the C\_ATTACH[0:2] pins are controlled by the CC\_POL pin. See Table 3-6 for details.

A diagram of a USB Type-C Downstream Facing Port with a USB5916, Microchip UTC2000, and external multiplexer is shown in Figure 8-1.

#### FIGURE 8-1: DFP TYPE-C PORT WITH MICROCHIP UTC2000 AND EXTERNAL MUX



#### 8.1.2 INTERNAL USB3.1 GEN 1 MULTIPLEXER, "TYPE-C CONTROL MODE 1"

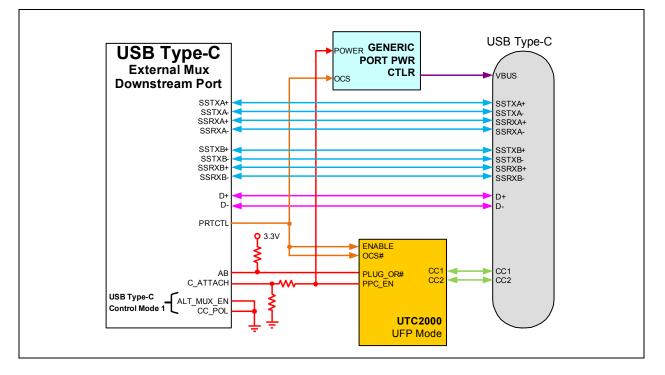
"Type-C Control Mode 1" is enabled by setting the ALT\_MUX\_EN signal low or leaving it floating. While in "Type-C Control Mode 1", the C\_ATTACH[0:1] and AB[0:1] pins are used together to signal to the hub when a valid USB Type-C connection has been detected and in what orientation the connection has been detected. This functionality requires an external USB Type-C controller such as a Microchip UTC2000 to monitor the USB Type-C receptacle for a valid attach. These signal are used to enable/disable the USB 3.1 Gen 1 PHYs appropriately according to the detected Type-C attach and orientation. Unused USB 3.1 Gen 1 PHYs are disabled to conserve power.

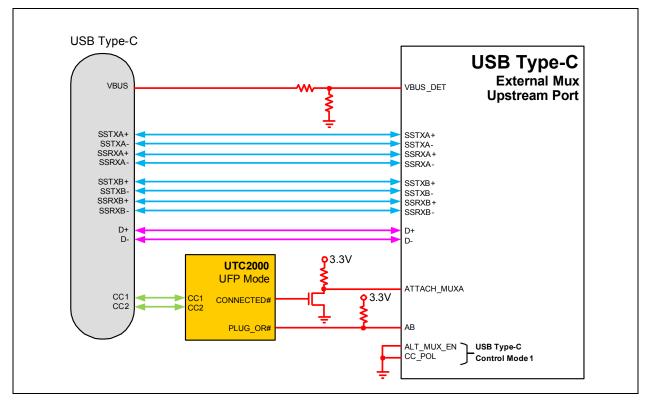
The polarity of the C\_ATTACH[0:1] pins and AB[0:1] are controlled by the CC\_POL pin. See Table 3-6 for details.

A diagram of a USB Type-C Downstream Facing Port with the USB5916, Microchip UTC2000, and internal multiplexer operating in "Type-C Control Mode 1" is shown in Figure 8-2.

A diagram of a USB Type-C Upstream Facing Port with the USB5916, Microchip UTC2000, and internal multiplexer operating in "Type-C Control Mode 1" is shown in Figure 8-3.

#### FIGURE 8-2: UFP TYPE-C PORT WITH MICROCHIP UTC2000 & EXTERNAL MUX (MODE 1)





#### FIGURE 8-3: UFP TYPE-C PORT WITH MICROCHIP UTC2000 & EXTERNAL MUX (MODE 1)

#### 8.1.3 INTERNAL USB 3.1 GEN 1 MULTIPLEXER, "TYPE-C CONTROL MODE 2"

"Type-C Control Mode 2" is enabled by setting the ALT\_MUX\_EN signal high. While in "Type-C Control Mode 2", the ATTACH\_MUX[0:1]A and ATTACH\_MUX[0:1]B pins are used to signal to the hub when a valid USB Type-C connection has been detected and in what orientation the connection has been detected. This functionality requires an external USB Type-C controller (this mode not directly supported by UTC2000) to monitor the USB Type-C receptacle for a valid attach. These signal are used to enable/disable the USB 3.1 Gen 1 PHYs appropriately according to the detected Type-C attach and orientation. Unused USB 3.1 Gen 1 PHYs are disabled to conserve power.

The polarity of the ATTACH\_MUX[0:1]A pins and ATTACH\_MUX[0:1]B are controlled by the CC\_POL pin. See Table 3-6 for details.

A diagram of a USB Type-C Downstream Facing Port with internal multiplexer operating in "Type-C Control Mode 2" with the USB5916 is shown in Figure 8-4.

A diagram of a USB Type-C Upstream Facing Port with internal multiplexer operating in "Type-C Control Mode 2" with the USB5916 is shown in Figure 8-5.

FIGURE 8-4: DFP TYPE-C PORT WITH GENERIC TYPE-C CONTROLLER AND INTERNAL MUX (MODE 2)

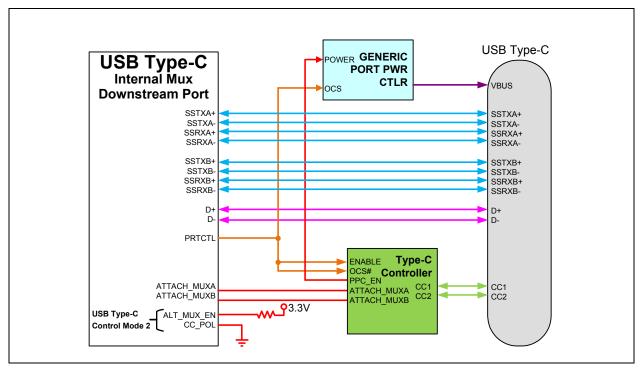
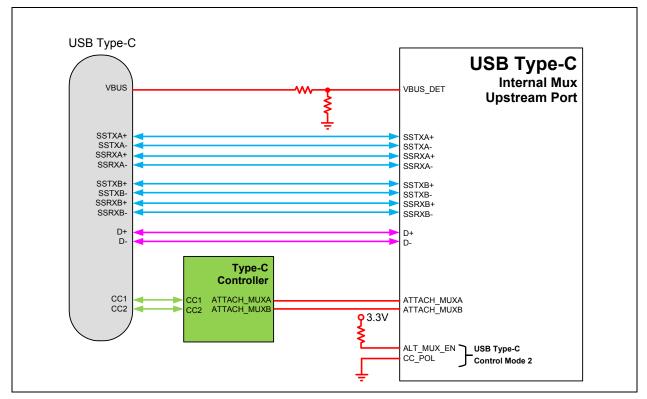


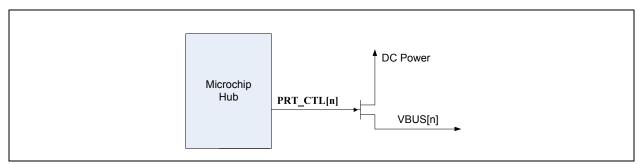
FIGURE 8-5: UFP TYPE-C PORT WITH GENERIC TYPE-C CONTROLLER & INTERNAL MUX (MODE 2)



#### 8.2 Battery Charging

The device can be configured by an OEM to have any of the downstream ports support battery charging. The hub's role in battery charging is to provide acknowledgment to a device's query as to whether the hub system supports USB battery charging. The hub silicon does not provide any current or power FETs or any additional circuitry to actually charge the device. Those components must be provided externally by the OEM.

#### FIGURE 8-6: BATTERY CHARGING EXTERNAL POWER SUPPLY



If the OEM provides an external supply capable of supplying current per the battery charging specification, the hub can be configured to indicate the presence of such a supply from the device. This indication, via the **PRT\_CTL[6:1]** pins, is on a per port basis. For example, the OEM can configure two ports to support battery charging through high current power FETs and leave the other two ports as standard USB ports.

For additional information, refer to the Microchip USB5916 Battery Charging application note on the Microchip.com/USB5916 product page www.microchip.com/USB5916.

#### 8.3 Resets

- Power-On Reset (POR)
- External Chip Reset (RESET\_N)
- USB Bus Reset

#### 8.3.1 POWER-ON RESET (POR)

A power-on reset occurs whenever power is initially supplied to the device, or if power is removed and reapplied to the device. A timer within the device will assert the internal reset per the specifications listed in Section 9.6.2, Power-On and Configuration Strap Timing.

#### 8.3.2 EXTERNAL CHIP RESET (RESET\_N)

A valid hardware reset is defined as assertion of **RESET\_N**, after all power supplies are within operating range, per the specifications in Section 9.6.3, Reset and Configuration Strap Timing. While reset is asserted, the device (and its associated external circuitry) enters Standby Mode and consumes minimal current.

Assertion of RESET\_N causes the following:

- 1. The PHY is disabled and the differential pairs will be in a high-impedance state.
- 2. All transactions immediately terminate; no states are saved.
- 3. All internal registers return to the default state.
- 4. The external crystal oscillator is halted.
- 5. The PLL is halted.

**Note:** All power supplies must have reached the operating levels mandated in Section 9.2, Operating Conditions\*\*, prior to (or coincident with) the assertion of RESET\_N.

#### 8.3.3 USB BUS RESET

In response to the upstream port signaling a reset to the device, the device performs the following:

- 1. Sets default address to 0.
- 2. Sets configuration to Unconfigured.
- 3. Moves device from suspended to active (if suspended).
- 4. Complies with the USB Specification for behavior after completion of a reset sequence.

The host then configures the device in accordance with the USB Specification.

Note: The device does not propagate the upstream USB reset to downstream devices.

#### 8.4 Link Power Management (LPM)

The device supports the L0 (On), L1 (Sleep), and L2 (Suspend) link power management states. These supported LPM states offer low transitional latencies in the tens of microseconds versus the much longer latencies of the traditional USB suspend/resume in the tens of milliseconds. The supported LPM states are detailed in Table 8-1.

State	Description	Entry/Exit Time to L0
L2	Suspend	Entry: ~3 ms Exit: ~2 ms (from start of RESUME)
L1	Sleep	Entry: <10 us Exit: <50 us
LO	Fully Enabled (On)	-

#### TABLE 8-1: LPM STATE DEFINITIONS

#### 8.5 Remote Wakeup Indicator

The remote wakeup indicator feature uses SUSP\_IND as a side band signal to wake up the host when in USB 2.0 suspend. This feature is enabled and disabled via the HUB\_RESUME\_INHIBIT configuration bit in the hub configuration space register HUB\_CFG\_3. The only way to control the bit is by configuration EEPROM, SMBus or internal ROM default setting. The state is only modified during a power on reset, or hardware reset. No dynamic reconfiguring of this capability is possible.

When HUB\_RESUME\_INHIBIT = '0', Normal Resume Behavior per the USB 2.0 specification

When HUB\_RESUME\_INHIBIT = '1', Modified Resume Behavior is enabled

Note:	The SUSP_IND signal only indicates the USB2.0 state.

#### 8.6 Port Control Interface

Port power and over-current sense share the same pin ( $PRT\_CTLx$ ) for each port. These functions can be controlled directly from the USB hub, or via the processor. Additionally, smart port controllers can be controlled via the  $l^2C$  interface.

The device can be configured into one of the two following port control modes:

- Ganged Mode A single GANG\_PWR pin controls power and detects over-current events for all downstream ports.
- Individual Mode Each port has an individual PRT\_CTLx pin for independent port power control and over-current detection.

Port connection in various modes are detailed in the following subsections.

#### 8.6.1 PORT CONNECTION IN GANGED MODE

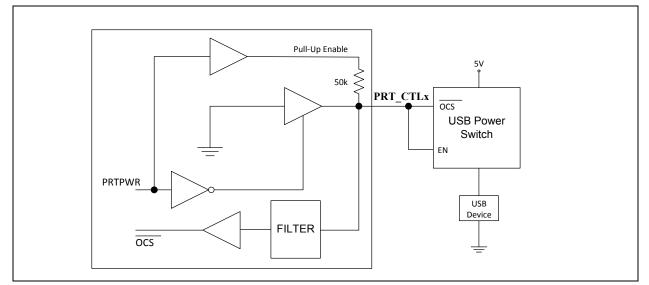
Ganged Mode is enabled via SMBus or OTP configuration. GANG\_PWR becomes the port control (PRTCTL) pin for all downstream ports when the hub is configured for ganged port power control mode. All port power controllers should be controlled from this pin when the hub is configured for ganged port power mode. While in this mode of operation, an over-current event on any single downstream port will cause all downstream ports to be flagged for over-current.

#### 8.6.2 PORT CONNECTION IN INDIVIDUAL MODE

#### 8.6.2.1 Port Power Control using USB Power Switch

Individual mode is the default mode of operation. When operating in individual mode, the device will have one port power control and over-current sense pin for each downstream port. When disabling port power, the driver will actively drive a '0'. To avoid unnecessary power dissipation, the pull-up resistor will be disabled at that time. When port power is enabled, it will disable the output driver and enable the pull-up resistor, making it an open drain output. If there is an over-current situation, the USB Power Switch will assert the open drain OCS signal. The Schmidt trigger input will recognize that as a low. The open drain output does not interfere. The over-current sense filter handles the transient conditions such as low voltage while the device is powering up.

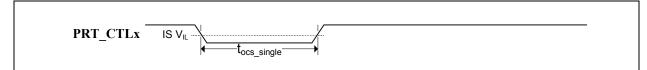




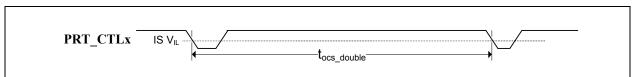
When the port is enabled, the **PRT\_CTLx** pin input is constantly sampled. Overcurrent events can be detected in one of two ways:

- Single, continuous low pulse (consecutive low samples over t<sub>ocs single</sub>), as shown in Figure 8-8.
- Two short low pulses within a rolling window (two groupings of 1 or more low samples over t<sub>ocs\_double</sub>), as shown in Figure 8-9.

#### FIGURE 8-8: SINGLE LOW PULSE OVERCURRENT DETECTION



# FIGURE 8-9: DOUBLE LOW PULSE OVERCURRENT DETECTION



To maximize compatibility with various port power control topologies, the parameters  $t_{ocs\_single}$  and  $t_{ocs\_double}$  are configurable via the Overcurrent Minimum Pulse Width Register and Overcurrent Inactive Timer Register.

The pin also has a turn-on "lockout" feature where the state of the pin is ignored for a configured amount of time immediately after port power is turned on. This prevents slow ramp times due to parasitic resistance/capacitance attached to the pin from triggering false overcurrent detections. This parameter is configurable via the Overcurrent Lockout Timer Register.

## TABLE 8-2: OVERCURRENT MINIMUM PULSE WIDTH REGISTER

OCS_MIN_WIDTH (30EAh)			Overcurrent Detection Pulse Window
BIT	Name	R/W	Description
7:4	Reserved	R	Reserved
3:0	OCS_MIN_WIDTH	R/W	The minimum overcurrent detection pulse width (t <sub>ocs_single</sub> ) is config- ured in this register. The range can be configured in 1ms increments from 0ms to 5ms. 0000 - 0ms minimum overcurrent detection pulse width 0001 - 1ms minimum overcurrent detection pulse width 0010 - 2ms minimum overcurrent detection pulse width 0011 - 3ms minimum overcurrent detection pulse width 0100 - 4ms minimum overcurrent detection pulse width 0101 - 5ms minimum overcurrent detection pulse width

#### TABLE 8-3: OVERCURRENT INACTIVE TIMER REGISTER

	OCS_INACTIVE_TIMER (30EBh)		Overcurrent Inactive Timer After First Overcurrent Detection
BIT	Name	R/W	Description
7:0	OCS_INACTIVE_TIMER	R/W	This register configures the timer within which a double low pulse triggers an overcurrent detection event ( $t_{ocs\_double}$ ).
			The timer can be incremented in 1ms steps. The default value is 20ms (14h).
			<b>Note:</b> This register should never be set to 00h.

# TABLE 8-4: OVERCURRENT LOCKOUT TIMER REGISTER

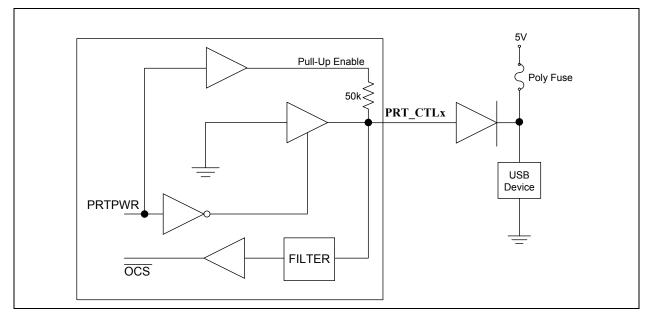
	START_LOCKOUT_TIMER_REG (30E1h)		Start Lockout Timer Register
BIT	Name	R/W	Description
7:0	START_LOCKOUT_TIMER_REG	R/W	The "start lockout timer" blocks an overcurrent event from being detected immediately after port power is turned on. Any overcurrent event within this timer value is ignored. The timer can be incremented in 1ms steps. The default value is 10ms (0Ah). <b>Note:</b> This register should never be set to 00h.

# 8.6.2.2 Port Power Control using Poly Fuse

When using the device with a poly fuse, there is no need for an output power control. To maintain consistency, the same circuit will be used. A single port power control and over-current sense for each downstream port is still used from the Hub's perspective. When disabling port power, the driver will actively drive a '0'. This will have no effect as the external diode will isolate pin from the load. When port power is enabled, it will disable the output driver and enable the pull-up resistor. This means that the pull-up resistor is providing 3.3 volts to the anode of the diode. If there is an over-current situation, the poly fuse will open. This will register this as a low resulting in an over-current detection. The open drain output does not interfere.

Note: The USB 2.0 and USB 3.1 Gen 1 bPwrOn2PwrGood descriptors must be set to 0 when using poly-fuse mode. Refer to the "Configuration Options for the USB58xx and USB59xx" Microchip application note for details on how to change these values.

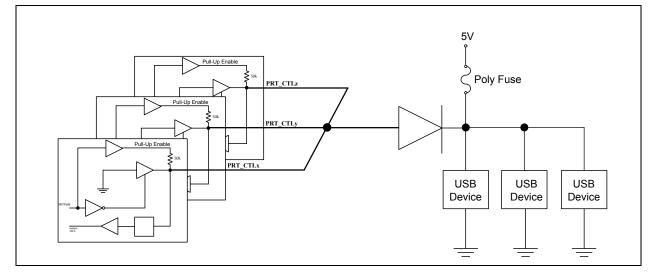
# FIGURE 8-10: PORT POWER CONTROL USING A POLY FUSE



## 8.6.2.3 Port Power Control with Single Poly Fuse and Multiple Loads

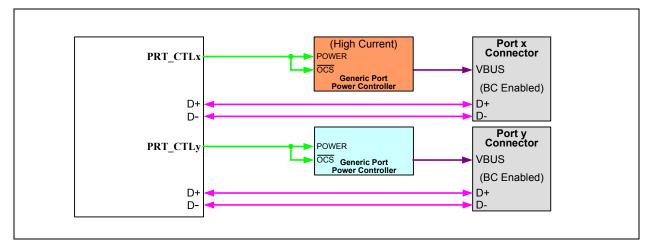
Many customers use a single poly fuse to power all their devices. For the ganged situation, all power control pins must be tied together.

# FIGURE 8-11: PORT POWER CONTROL WITH GANGED CONTROL WITH POLY FUSE



## 8.6.3 PORT CONTROLLER CONNECTION EXAMPLE

## FIGURE 8-12: GENERIC PORT POWER CONTROLLERS



**Note:** The <u>CFG\_BC\_EN</u> configuration strap must be properly configured to enable battery charging on the appropriate ports. For more information on the <u>CFG\_BC\_EN</u> configuration strap, refer to Section 3.5.4, Battery Charging Configuration (CFG\_BC\_EN).

# 8.7 Port Split

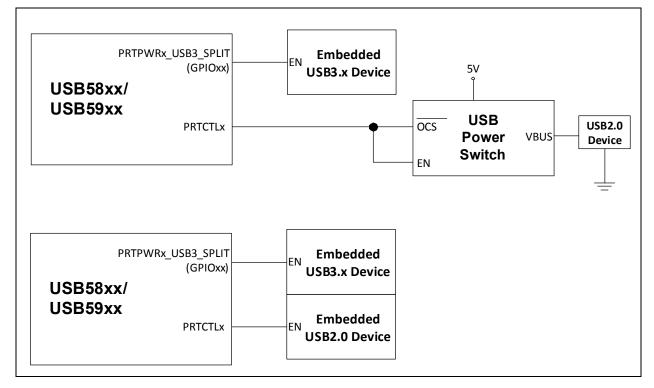
# 8.7.1 FEATURE OVERVIEW

This feature allows the USB 2.0 and USB 3.1 Gen 1 PHYs associated with any downstream port to be operationally separated. The intention of this feature is to allow a system designer to connect an embedded USB 3.x device to the USB 3.1 Gen 1 PHY, while allowing the USB 2.0 PHY to be used as either a standard USB 2.0 port or with a separate embedded USB 2.0 device.

This feature operates outside of the provisions of the USB specifications. Operation is intended for specialized applications only. Contact your local sales representative for additional information.

In order to maintain a positive end user experience, it is recommended that only permanently attached, embedded USB 3.x devices be connected to the USB 3.1 Gen 1 PHY when enabling the Port Split feature. This prevents end users from attempting to connect USB High-Speed, Full-Speed, or Low-Speed devices to an exposed USB port which only has USB 3.1 Gen 1 connections.





# 8.7.2 PORT SPLITTING CONFIGURATION

Downstream ports 4 and 5 may be configured for Port Splitting. Port Splitting is configured via register configuration through SMBus during the hub configuration stage (SOC\_CFG) or via the hub's internal OTP memory.

When Port Splitting is enabled, the existing PRT\_CTLx pin associated with that port will continue to control the USB 2.0 portion of the port in an identical matter. A new pin function assigned to a GPIOx pin will be activated and configured to control the USB 3.1 Gen 1 portion of the port. This new pin is named PRTPWRx\_USB3\_SPLIT where x indicates the respective port. Note that overcurrent detection is not supported on the PRTPWRx\_USB3\_SPLIT pin. These new pins are assigned as shown in Table 8-5.

GPIOx Pin	Port Split Assignment
GPIO66	PRTPWR4_USB3_SPLIT Option A
GPIO6	PRTPWR5_USB3_SPLIT Option A
GPIO5	PRTPWR4_USB3_SPLIT Option B
GPIO4	PRTPWR5_USB3_SPLIT Option B

## 8.7.2.1 Enabling Port Splitting

In order to enable the Port Splitting feature on downstream ports 4 and/or5, the following configuration settings must be made.

#### **Enabling Port Splitting on Port 4:**

- Write 0x42 to register 0x416E to select GPIO66 for Option A
- Write 0x05 to register 0x416E to select GPIO5 for Option B
- Set bit 5 of the USB3\_PORT\_SPLIT\_EN (0x3C48 = 0x20)

#### Enabling Port Splitting on Port 5:

- Write 0x06 to register 0x416F to select GPIO6 for Option A
- Write 0x04 to register 0x416F to select GPIO4 for Option B
- Set bit 6 of the USB3\_PORT\_SPLIT\_EN (0x3C48 = 0x40)

#### TABLE 8-6:USB 3.0 PORT SPLIT ENABLE REGISTER

	USB3_PORT_SPLIT_EN (0x3C48 - RESET = 0x00)		USB 3.0 Port Split Enable
BIT	Name	R/W	Description
7:1	PORT_SPLIT_EN[7:1]	R/W	0 = Port Splitting on the specified port is disabled 1 = Port Splitting on the specified port is enabled Bit [1] - Reserved [2] - Reserved [3] - Reserved [4] - Reserved [5] - Port 4 [6] - Port 5 [7] - Reserved
0	Reserved	R	Reserved

# 8.7.2.2 Link Timeout Reset

Port Splitting is intended for use with embedded USB 3.x devices only. When Port Splitting is enabled, the hub constantly monitors the USB 3.1 Gen 1 Link to see if a valid USB 3.1 Gen 1 Link is established. If there is no valid USB 3.1 Gen 1 Link for a configured amount of time (see below), then the hub will toggle assertion of the associated "PRTPWRx-USB3\_SPLIT" pin in an attempt to reset the embedded USB 3.1 Gen 1 device and re-establish the USB 3.1 Gen 1 Link. The timer is always reset and restarted whenever the timeout occurs.

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A valid USB 3.1 Gen 1 link is qualified by the LTSSM\_STATE register status for the port. A normal Link will actively switch through many Link states.

If the hub detects that the Link is staying in one of the following Link states the entire duration of the timeout timer, then the Link is stuck in an invalid state and PRTPWRx\_USB3\_SPLIT will be toggled in order to attempt to re-establish the Link.

- SIS.Disabled(0x4)
- Rx.Detect(0x5)
- · SS.Inactive(0x6)
- Polling(0x7)
- Recovery(0x8)
- HotReset (0x9)

The Link Timeout Reset value is configured via register 0x4171 and can be overridden by OTP. The default value is 0x05, which selects a Timeout value of 1 second. Setting the register to 0x00 will disable the Link Timeout Reset feature.

The duration of the Link reset (time which **PRTPWRx\_USB3\_SPLIT** signal stays low) can be configured in register 0x4176. The default duration is 400ms with a configurable range of 350ms to 2.9s.

# 8.8 USB Billboard Device Class Support

#### USB3\_PORT\_SPLIT\_TIMEOUT **USB 3.X PORT SPLIT LINK TIMEOUT REGISTER** (0X4171 - RESET=0X05) NAME DESCRIPTION BIT R/W [7:3] Reserved R/W Always read '0' [2:0] PORT\_SPLIT\_TIMEOUT[ R/W Global USB Port Splitting Link Timeout Value 2:0] If Port Splitting is enabled on a port and there is no valid USB 3.x Link for the configured amount of time, then the associated "PRTPWRx\_USB3 SPLIT" pin will be toggled in an attempt to reset the embedded USB 3.x device and re-establish the USB 3.x Link. The timer is always reset and restarted whenever the timeout occurs. 000b - No Timeout, never toggle PRTPWRx USB3 SPLIT 001b - 100ms 010b - 250ms 011b - 500ms 100b - 750ms 101b - 1 second 110b - 2 second 111b - Reserved

#### TABLE 8-7: USB 3.X PORT SPLIT LINK TIMEOUT REGISTER

#### TABLE 8-8:USB 3.X PORT SPLIT TOGGLE TIME REGISTER

USB3_PORT_SPLIT_TOGGLE_TIME (0X4176 - RESET=0X05)		ИE	USB 3.X PORT SPLIT TOGGLE TIME REGISTER
BIT	NAME	R/W	DESCRIPTION
[7:0]	PORT_SPLIT_TOGGLE_ TIME[7:0]	R/W	The PORT_SPLIT_TOGGLE_TIME is used to control the length of time port power is toggled off. This is specific to the "PRTPWRx_USB3_SPLIT" pin, and is only used in conjunction with 0X4171. The timer is always reset whenever the toggle completes. The minimum toggle time is 350ms and is represented by 0000000b. Each incremental value will add 10ms to the 350ms minimum value.

USB Billboard is supported by the USB5916 in conjunction with an external USB Power Delivery capable controller that supports the USB PD stack and alternate mode negotiation.

When a USB Type-C enabled product supports alternate modes for enhanced capability beyond what is available through USB connectivity alone, that product must support a USB Billboard endpoint so that a user will be notified by an operating system when the enhanced capability is not enabled due to an alternate mode mismatch.

A good example of alternate mode functionality is support for a DisplayPort monitor that many docking stations provide. In this case, the docking station offers DisplayPort (DP) capability over the USB-C connector as an alternate mode. The DP monitor will only function correctly when a successful alternate mode negotiation occurs between the docking station and the notebook PC (this is the USB-C to USB-C connection). In order for the alternate mode negotiation to succeed, the Notebook and the Docking Station must both support DP over USB-C, and have the DP messaging capability enabled to support alternate mode negotiation. If the alternate mode negotiation is successful, then the notebook and the Docking Station both change their multiplexers to enable DP signaling over USB Type-C. In this case, no USB Billboard messages need to be displayed.

If the above example instead uses a notebook that doesn't support DP over USB-C, then the alternate mode negotiation will fail. The docking station will not have a way to enable the DP monitor capability, reducing functionality for the customer. For this is the reason, USB Billboard capability is mandated. In this case, a USB Billboard device class endpoint must appear on a hub port within the Docking Station, and it must provide text and or a web site link which will provide information to the user regarding the corrective steps required to use the feature.

In the case of the USB5916, all of the above mentioned negotiation capability will occur outside of the USB5916 via an external USB Power Delivery capable device that contains a full USB PD stack and can communicate via USB PD messaging. In an alternate mode failure case, the USB5916 will provide that message by allowing the USB host to enumerate an internal USB Billboard Device Class just after the failure in response to a signal from the external USB PD controller. The Billboard Device descriptors will contain the failure message to the USB Host. The message itself will be prerecorded in the device's OTP memory.

#### 8.8.1 BILLBOARD ENABLE IN OTP AND GPIOX PIN USE

Any of the GPIOx pins may be selected to use as the BILLBOARD\_EN input. By default, GPIO68 is selected when the Billboard feature is enabled.

The **BILLBOARD\_EN** input signal is active low. When the pin is driven low by a Power Delivery controller to indicate an alternate mode negotiation failure, the Billboard functionality will activate.

## TABLE 8-9: USB BILLBOARD CONTROL

USBBILLBOARDCNTL (OTP ADDR4 - RESET=0X14)			USB BILLBOARD CONTROL
BIT	NAME	R/W	DESCRIPTION
[7:6]	Reserved	R/W	Always read '0'
[5:1]	BILLBOARD_EN Pin Select	R/W	00000= GPI064 0001= GPI01 00010= GPI02 00011= GPI03 00100= GPI065 00101= GPI066 00110= GPI067 00111= GPI023 01000= GPI010 01001= Reserved 01010= GPI068 (default) 01011= GPI06 01100= GPI069 01101= GPI070 01110= GPI071 01111= GPI05 10000= GPI04
[0]	Billboard Support Enable	R/W	0 = Billboard support disabled 1 = Billboard support enabled

# 8.8.2 BILLBOARD ENDPOINT FUNCTIONALITY

When the applicable GPIOx pin is 0, which indicates that Billboard device must be displayed, the following sequence of events will occur:

- 1. USB5916 will force the Hub Feature Controller internal device to disconnect from the USB Hub port (emulating a physical detach)
- 2. USB5916 will force the Hub Feature Controller to re-connect with descriptors that will show the Hub Feature Controller endpoint is a Billboard device, compliant to version 1.1 of the Billboard device class specification.
- 3. USB5916 will start a timer (Timer A) when the Host sets the Hub Feature Controller USB address. This timer will be used to ensure that the Billboard endpoint will not remain permanently attached if it is never accessed. The default Timer A timeout is 20 seconds.
- 4. This implementation will only support Billboard when a failure occurs, therefore the Device Container uses a static list of device capabilities and will only expose the Billboard Device on failure to enter into Modal Operation and will set the **bmConfigured** descriptor field to "Unspecified Error" (00b) by default.
- 5. The Hub Feature Controller will Provide the *iAlternateModeString* when the host requests it, and will start a timer (Timer B). The default Timer B timeout is 20 seconds.
- 6. When either timer expires, the USB5916 will force the Hub Feature Controller internal device to disconnect from the USB Hub port (emulating a physical detach).
- 7. USB5916 will force the Hub Feature Controller to re-connect with the standard Hub Feature Controller Functionality.

	DETACH_TIMER_A_LSB (413Ch)		Billboard Detach Timer A LSB
BIT	Name	R/W	Description
7:0	TIMEOUT	R/W	Timer A is started as soon as the Hub Feature Controller's Billboard Class Device address is set by the host. Once the timer expires, the Billboard Class Device will automatically detach from the host and re- attach as the default WinUSB device.
			Increments of 10ms can be set. The default value of 413Ch = D0h, 413Dh = 07h is equivalent to a 20s timeout. (07D0h = 2000d)

# TABLE 8-11: TIMER A: BILLBOARD DETACH TIMER MSB

	DETACH_TIMER_A_MSB (413Dh)		Billboard Detach Timer A MSB
BIT	Name	R/W	Description
7:0	TIMEOUT	R/W	Timer A is started as soon as the Hub Feature Controller's Billboard Class Device address is set by the host. Once the timer expires, the Billboard Class Device will automatically detach from the host and re- attach as the default WinUSB device.
			Note: The default value of 413Ch = D0h, 413Dh = 07h is equiv- alent to a 20s timeout. (07D0h = 2000d)

# TABLE 8-12: TIMER B: BILLBOARD DETACH TIMER LSB

	DETACH_TIMER_B_LSB (413Eh)		Billboard Detach Timer B LSB
BIT	Name	R/W	Description
7:0	TIMEOUT	R/W	Timer B is started as soon as the host requests iAlternateModeString. Once the timer expires, the Billboard Class Device will automatically detach from the host and re-attach as the default WinUSB device.
			Increments of 10ms can be set.
			The default value of 413Ch = D0h, 413Dh = 07h is equivalent to a 20s timeout. (07D0h = 2000d)

# TABLE 8-13: TIMER B: BILLBOARD DETACH TIMER MSB

	DETACH_TIMER_B_MSB (413Fh)		Billboard Detach Timer A MSB			
BIT	Name	R/W	Description			
7:0	TIMEOUT	R/W	Timer B is started as soon as the host requests iAlternateModeString. Once the timer expires, the Billboard Class Device will automatically detach from the host and re-attach as the default WinUSB device. Increments of 10ms can be set.			
			<b>Note:</b> The default value of 413Ch = D0h, 413Dh = 07h is equivalent to a 20s timeout. (07D0h = 2000d)			

# 8.8.3 BILLBOARD DEVICE DESCRIPTORS

The AlternateModeString and iAdditionalInfoURL descriptors can be configured in the hub to provide the user with additional information about the Alternate Mode failure.

Offset: 0	Offset: +1	Offset: +2	Offset: +3
			iAdditionalInfoURL
			Default = 01h
bNumberOfAlternate-	bPreferredAlternateMode	VCONN Power[0]	VCONN Power[1]
Modes	Default = 00h	Default = 00h	Default = 80h
Default = 01h			
bmConfigured[0]	bmConfigured[1]	bmConfigured[2]	bmConfigured[3]
Default = 00h	Default = 00h	Default = 00h	Default = 00h
bmConfigured[4]	bmConfigured[5]	bmConfigured[6]	bmConfigured[7]
Default = 00h	Default = 00h	Default = 00h	Default = 00h
bmConfigured[8]	bmConfigured[9]	bmConfigured[10]	bmConfigured[11]
Default = 00h	Default = 00h	Default = 00h	Default = 00h
bmConfigured[12]	bmConfigured[13]	bmConfigured[14]	bmConfigured[15]
Default = 00h	Default = 00h	Default = 00h	Default = 00h
bmConfigured[16]	bmConfigured[17]	bmConfigured[18]	bmConfigured[19]
Default = 00h	Default = 00h	Default = 00h	Default = 00h
bmConfigured[20]	bmConfigured[21]	bmConfigured[22]	bmConfigured[23]
Default = 00h	Default = 00h	Default = 00h	Default = 00h
bmConfigured[24]	bmConfigured[25]	bmConfigured[26]	bmConfigured[27]
Default = 00h	Default = 00h	Default = 00h	Default = 00h

# TABLE 8-14: BILLBOARD DEVICE DESCRIPTORS

TABLE 8-14:	<b>BILLBOARD DEVICE DESCRIPTORS (</b>	(CONTINUED)	)
-------------	---------------------------------------	-------------	---

Offset: 0	Offset: +1	Offset: +2	Offset: +3					
bmConfigured[28] bmConfigured[29]		bmConfigured[30]	bmConfigured[31]					
Default = 00h	Default = 00h	Default = 00h	Default = 00h					
bcdVersion[0]	bcdVersion[1]	bAdditonalFailureInfo	bReserved					
Default = 10h	Default = 01h	Default = 00h	Default = 00h					
wSVID[0]	wSVID[1]	bAlternateMode						
Default = 00h	Default = FFh	Default = 00h						

# 9.0 OPERATIONAL CHARACTERISTICS

# 9.1 Absolute Maximum Ratings\*

+1.2 V Supply Voltage (VDD12) (Note 1)	0.5 V to +1.32 V
+3.3 V Supply Voltage (VDD33) (Note 1)	0.5 V to +4.6 V
Positive voltage on input signal pins, with respect to ground (Note 2)	+4.6 V
Negative voltage on input signal pins, with respect to ground	0.5 V
Positive voltage on XTALI/CLKIN, with respect to ground	+3.63 V
Positive voltage on USB DP/DM signal pins, with respect to ground	+6.0 V
Positive voltage on USB 3.1 Gen 1 USB3UP_xxxx and USB3DN_xxxx signal pins, with respect to group of the second sec	ound 1.32 V
Storage Temperature	55°C to +150°C
Junction Temperature	+125 <sup>o</sup> C
Lead Temperature Range	Spec. J-STD-020
HBM ESD Performance	3 kV

**Note 1:** When powering this device from laboratory or system power supplies, it is important that the absolute maximum ratings not be exceeded or device failure can result. Some power supplies exhibit voltage spikes on their outputs when AC power is switched on or off. In addition, voltage transients on the AC power line may appear on the DC output. If this possibility exists, it is suggested to use a clamp circuit.

Note 2: This rating does not apply to the following pins: All USB DM/DP pins, XTAL1/CLKIN, and XTALO

\*Stresses exceeding those listed in this section could cause permanent damage to the device. This is a stress rating only. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Functional operation of the device at any condition exceeding those indicated in Section 9.2, Operating Conditions\*\*, Section 9.5, DC Specifications, or any other applicable section of this specification is not implied.

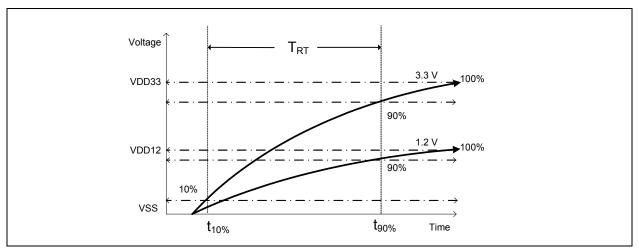
# 9.2 Operating Conditions\*\*

+1.2 V Supply Voltage (VDD12)	+1.08 V to +1.32 V
+3.3 V Supply Voltage (VDD33)	+3.0 V to +3.6 V
Input Signal Pins Voltage (Note 2)	0.3 V to +3.6 V
XTALI/CLKIN Voltage	0.3 V to +3.6 V
USB 2.0 DP/DM Signal Pins Voltage	0.3 V to +5.5 V
USB 3.1 Gen 1 USB3UP_xxxx and USB3DN_xxxx Signal Pins Voltage	0.3 V to +1.32 V
Ambient Operating Temperature in Still Air (T <sub>A</sub> )	Note 3
+1.2 V Supply Voltage Rise Time (T <sub>RT</sub> in Figure 9-1)	
+3.3 V Supply Voltage Rise Time (T <sub>RT</sub> in Figure 9-1)	
<b>Note 3:</b> $0^{\circ}$ C to +70°C for commercial version, -40°C to +85°C for industrial version.	

\*\*Proper operation of the device is guaranteed only within the ranges specified in this section.

Note: Do not drive input signals without power supplied to the device.





Note: The rise time for the 3.3 V supply can be extended to 100ms max if RESET\_N is actively driven low, typically by another IC, until 1  $\mu$ s after all supplies are within operating range.

# 9.3 Package Thermal Specifications

#### TABLE 9-1:PACKAGE THERMAL PARAMETERS

Symbol	°C/W	Velocity (Meters/s)
0	19	0
$\Theta_{JA}$	16	1
W	0.1	0
$\Psi_{JT}$ –	0.1	1
Θ	1.4	0
$\Theta_{JC}$	1.4	1

Note: Thermal parameters are measured or estimated for devices in a multi-layer 2S2P PCB per JESDN51.

#### TABLE 9-2: MAXIMUM POWER DISSIPATION

Parameter	Value	Units	
PD(max)	1.94	W	

# 9.4 **Power Consumption**

The values shown below represent typical power consumption as measured during various modes of operation. Power dissipation is determined by temperature, supply voltage, and external source/sink requirements.

The following measurements were taken with VDD33 equal to 3.3V, VDD12 equal to 1.2V, at an ambient temperature of 25°C.

**Note:** A USB 3.x hub operates both the USB 3.x and USB 2.0 interfaces in parallel on it's upstream port connection. A port operating under the SS/HS condition indicates that a USB 3.x hub was connected to it.

Typical Power
2 (mW)
28
28
32
1,214
1,391
;

# TABLE 9-3: DEVICE POWER CONSUMPTION

**Note:** Actual power consumption will vary depending on the capabilities of the USB host, the devices connected, data type, and data bus utilization. The published data represents typical power consumption of the hub at nominal ambient temperature and supply voltage while large file transfers are active between USB host and USB Mass Storage class devices on all downstream ports.

Typical power consumption for specific use cases can be estimated using the formulas below:

$$\begin{split} &I_{VDD33}(mA) = 35 + (N_{PORTSFS})(1)^* + (N_{PORTSHS})(10) + (N_{PORTSSS})(7) \\ &I_{VDD12}(mA) = 245 + (N_{PORTSFS})(0.1)^* + (N_{PORTSHS})(2) + (N_{PORTSSS})(109) \\ &P_{TOTAL}(mW) = 409.5 + (N_{PORTSFS})(3.42)^* + (N_{PORTSHS})(35.4) + (N_{PORTSSS})(153.9) \end{split}$$

# 9.5 DC Specifications

# TABLE 9-4: I/O DC ELECTRICAL CHARACTERISTICS

Parameter	Symbol	Min	Typical	Max	Units	Notes
I Type Input Buffer						
Low Input Level	V <sub>IL</sub>			0.9	V	
High Input Level	V <sub>IH</sub>	2.1			V	
IS Type Input Buffer						
Low Input Level	V <sub>IL</sub>			0.9	V	
High Input Level	$V_{\text{IH}}$	1.9			V	
Schmitt Trigger Hysteresis (V <sub>IHT</sub> - V <sub>ILT</sub> )	$V_{HYS}$	9	20	40	mV	
O6 Type Output Buffer						
Low Output Level	V <sub>OL</sub>			0.4	V	I <sub>OL</sub> = 6 mA
High Output Level	V <sub>OH</sub>	VDD33-0.4			V	I <sub>OH</sub> = -6 mA

Parameter	Symbol	Min	Typical	Max	Units	Notes
O12 Type Output Buffer						
Low Output Level	V <sub>OL</sub>			0.4	V	I <sub>OL</sub> = 12 mA
High Output Level	V <sub>OH</sub>	VDD33-0.4			V	I <sub>OH</sub> = -12 mA
OD12 Type Output Buffer						
Low Output Level	V <sub>OL</sub>			0.4	V	I <sub>OL</sub> = 12 mA
ICLK Type Input Buffer (XTALI Input)						Note 4
Low Input Level	V <sub>IL</sub>			0.50	V	
High Input Level	V <sub>IH</sub>	0.85		VDD33	V	
IO-U Type Buffer (See Note 5)						Note 5

TABLE 9-4: I/O DC ELECTRICAL CHARACTERISTICS (CONTINUED)

**Note 4:** XTALI can optionally be driven from a 25 MHz singled-ended clock oscillator.

Note 5: Refer to the USB 3.1 Gen 1 Specification for USB DC electrical characteristics.

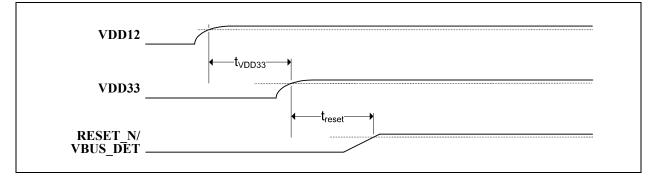
# 9.6 AC Specifications

This section details the various AC timing specifications of the device.

# 9.6.1 POWER SUPPLY AND RESET\_N SEQUENCE TIMING

Figure 9-2 illustrates the recommended power supply sequencing and timing for the device. VDD33 should rise after or at the same rate as VDD12. Similarly, RESET\_N and/or VBUS\_DET should rise after or at the same rate as VDD33. VBUS\_DET and RESET\_N do not have any other timing dependencies.

# FIGURE 9-2: POWER SUPPLY AND RESET\_N SEQUENCE TIMING



#### TABLE 9-5: POWER SUPPLY AND RESET\_N SEQUENCE TIMING

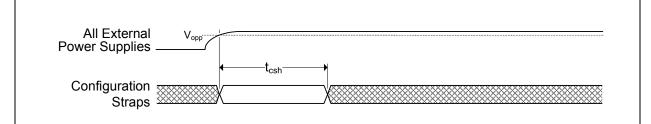
Symbol	Description	Min	Тур	Мах	Units
t <sub>VDD33</sub>	VDD12 to VDD33 rise time	0			ms
t <sub>reset</sub>	VDD33 to RESET_N/VBUS_DET rise time	0			ms

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#### 9.6.2 POWER-ON AND CONFIGURATION STRAP TIMING

Figure 9-3 illustrates the configuration strap valid timing requirements in relation to power-on, for applications where **RESET\_N** is not used at power-on. In order for valid configuration strap values to be read at power-on, the following timing requirements must be met. The operational levels ( $V_{opp}$ ) for the external power supplies are detailed in Section 9.2, Operating Conditions\*\*.





## TABLE 9-6: POWER-ON CONFIGURATION STRAP LATCHING TIMING

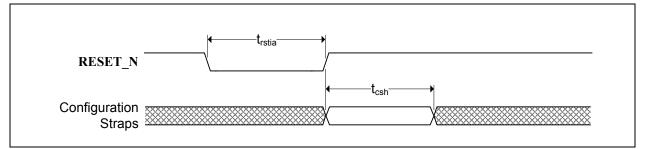
Symbol	Description		Тур	Мах	Units
t <sub>csh</sub>	Configuration strap hold after external power supplies at opera- tional levels	1			ms

Device configuration straps are also latched as a result of **RESET\_N** assertion. Refer to Section 9.6.3, Reset and Configuration Strap Timing for additional details.

# 9.6.3 RESET AND CONFIGURATION STRAP TIMING

Figure 9-4 illustrates the **RESET\_N** pin timing requirements and its relation to the configuration strap pins. Assertion of **RESET\_N** is not a requirement. However, if used, it must be asserted for the minimum period specified. Refer to Section 8.3, Resets for additional information on resets. Refer to Section 3.5, Configuration Straps and Programmable Functions for additional information on configuration straps.

# FIGURE 9-4: RESET\_N CONFIGURATION STRAP TIMING



#### TABLE 9-7: RESET\_N CONFIGURATION STRAP TIMING

Symbol	Description		Тур	Мах	Units
t <sub>rstia</sub>	RESET_N input assertion time	5			μS
t <sub>csh</sub>	Configuration strap pins hold after RESET_N deassertion	1			ms

**Note:** The clock input must be stable prior to **RESET\_N** deassertion.

Configuration strap latching and output drive timings shown assume that the Power-On reset has finished first otherwise the timings in Section 9.6.2, Power-On and Configuration Strap Timing apply.

#### 9.6.4 USB TIMING

All device USB signals confirm to the voltage, power, and timing characteristics/specifications as set forth in the *Universal Serial Bus Specification*. Please refer to the *Universal Serial Bus Revision 3.1 Specification*, available at http://www.usb.org/developers/docs.

# 9.6.5 $I^2C$ TIMING

All device  $l^2C$  signals confirm to the 100KHz Standard Mode (Sm) voltage, power, and timing characteristics/specifications as set forth in the  $l^2C$ -Bus Specification. Please refer to the  $l^2C$ -Bus Specification, available at http://www.nxp.com/ documents/user\_manual/UM10204.pdf.

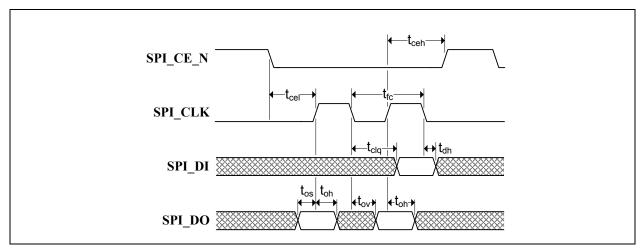
#### 9.6.6 SMBUS TIMING

All device SMBus signals confirm to the voltage, power, and timing characteristics/specifications as set forth in the System Management Bus Specification. Please refer to the System Management Bus Specification, Version 1.0, available at http://smbus.org/specs.

# 9.6.7 SPI TIMING

This section specifies the SPI timing requirements for the device.

## FIGURE 9-5: SPI TIMING



#### TABLE 9-8: SPI TIMING (30 MHZ OPERATION)

Symbol	Description	Min	Тур	Max	Units
t <sub>fc</sub>	Clock frequency			30	MHz
t <sub>ceh</sub>	Chip enable (SPI_CE_EN) high time	100			ns
t <sub>clq</sub>	Clock to input data			13	ns
t <sub>dh</sub>	Input data hold time	0			ns
t <sub>os</sub>	Output setup time	5			ns
t <sub>oh</sub>	Output hold time	5			ns
t <sub>ov</sub>	Clock to output valid	4			ns
t <sub>cel</sub>	Chip enable (SPI_CE_EN) low to first clock	12			ns
t <sub>ceh</sub>	Last clock to chip enable (SPI_CE_EN) high	12			ns

#### TABLE 9-9: SPI TIMING (60 MHZ OPERATION)

Symbol	Description	Min	Тур	Мах	Units
t <sub>fc</sub>	Clock frequency			60	MHz

Symbol	Description	Min	Тур	Мах	Units
t <sub>ceh</sub>	Chip enable (SPI_CE_EN) high time	50			ns
t <sub>clq</sub>	Clock to input data			9	ns
t <sub>dh</sub>	Input data hold time	0			ns
t <sub>os</sub>	Output setup time	5			ns
t <sub>oh</sub>	Output hold time	5			ns
t <sub>ov</sub>	Clock to output valid	4			ns
t <sub>cel</sub>	Chip enable (SPI_CE_EN) low to first clock	12			ns
t <sub>ceh</sub>	Last clock to chip enable (SPI_CE_EN) high	12			ns

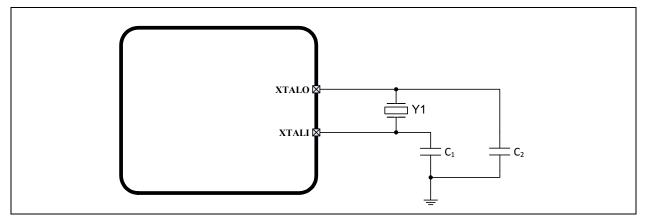
## TABLE 9-9: SPI TIMING (60 MHZ OPERATION)

# 9.7 Clock Specifications

The device can accept either a 25MHz crystal or a 25MHz single-ended clock oscillator (±50ppm) input. If the singleended clock oscillator method is implemented, XTALO should be left unconnected and XTALI/CLKIN should be driven with a nominal 0-3.3V clock signal. The input clock duty cycle is 40% minimum, 50% typical and 60% maximum.

It is recommended that a crystal utilizing matching parallel load capacitors be used for the crystal input/output signals (XTALI/XTALO). The following circuit design (Figure 9-6) and specifications (Table 9-10) are required to ensure proper operation.





# 9.7.1 CRYSTAL SPECIFICATIONS

It is recommended that a crystal utilizing matching parallel load capacitors be used for the crystal input/output signals (XTALI/XTALO). Refer to Table 9-10 for the recommended crystal specifications.

PARAMETER	SYMBOL	MIN	NOM	MAX	UNITS	NOTES
Crystal Cut	· · · · · ·					
Crystal Oscillation Mode		Fund	damental Mode	9		
Crystal Calibration Mode		Paralle	el Resonant Mo	ode		
Frequency	F <sub>fund</sub>	-	25.000	-	MHz	
Frequency Tolerance @ 25°C	F <sub>tol</sub>	-	-	±50	PPM	
Frequency Stability Over Temp	F <sub>temp</sub>	-	-	±50	PPM	
Frequency Deviation Over Time	F <sub>age</sub>	-	±3 to 5	-	PPM	Note 6
Total Allowable PPM Budget		-	-	±100	PPM	Note 7
Shunt Capacitance	C <sub>O</sub>	-	7 typ	-	pF	

## TABLE 9-10: CRYSTAL SPECIFICATIONS (CONTINUED)

PARAMETER	SYMBOL	MIN	NOM	MAX	UNITS	NOTES
Load Capacitance	CL	-	20 typ	-	pF	
Drive Level	P <sub>W</sub>	100	-	-	uW	
Equivalent Series Resistance	R <sub>1</sub>	-	-	60	Ω	
Operating Temperature Range		Note 7	-	Note 8	°C	
XTALI/CLKIN Pin Capacitance		-	3 typ	-	pF	Note 9
XTALO Pin Capacitance		-	3 typ	-	pF	Note 9

Note 6: Frequency Deviation Over Time is also referred to as Aging.

Note 7: 0 °C for commercial version, -40 °C for industrial version.

- **Note 8:** +70 °C for commercial version, +85 °C for industrial version.
- **Note 9:** This number includes the pad, the bond wire and the lead frame. PCB capacitance is not included in this value. The **XTALI/CLKIN** pin, **XTALO** pin and PCB capacitance values are required to accurately calculate the value of the two external load capacitors. These two external load capacitors determine the accuracy of the 25.000 MHz frequency.

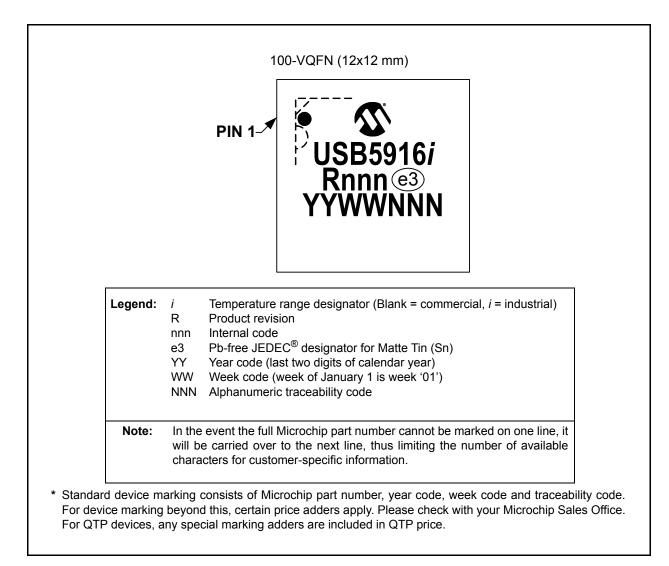
# 9.7.2 EXTERNAL REFERENCE CLOCK (CLKIN)

When using an external reference clock, the following input clock specifications are suggested:

- 25 MHz
- 50% duty cycle ±10%, ±100 ppm
- Jitter < 100 ps RMS

# **10.0 PACKAGE INFORMATION**

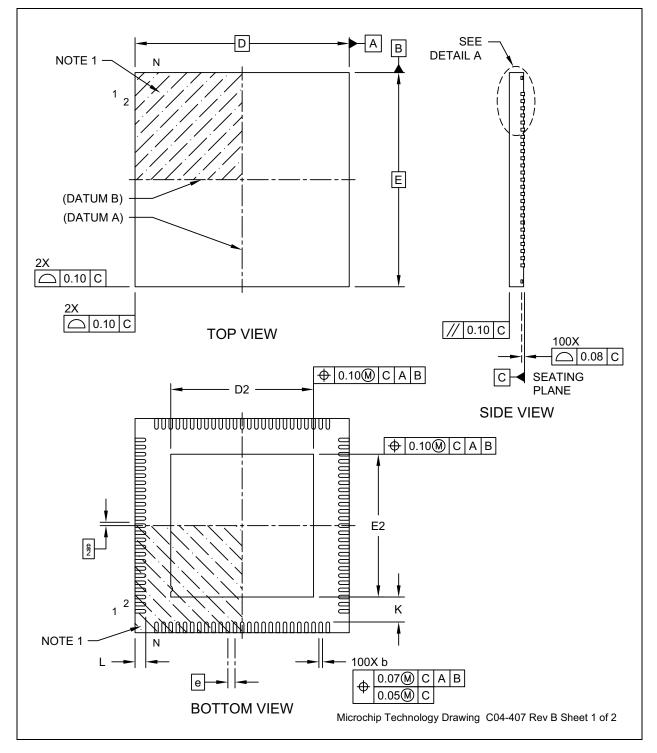
# 10.1 Package Marking Information

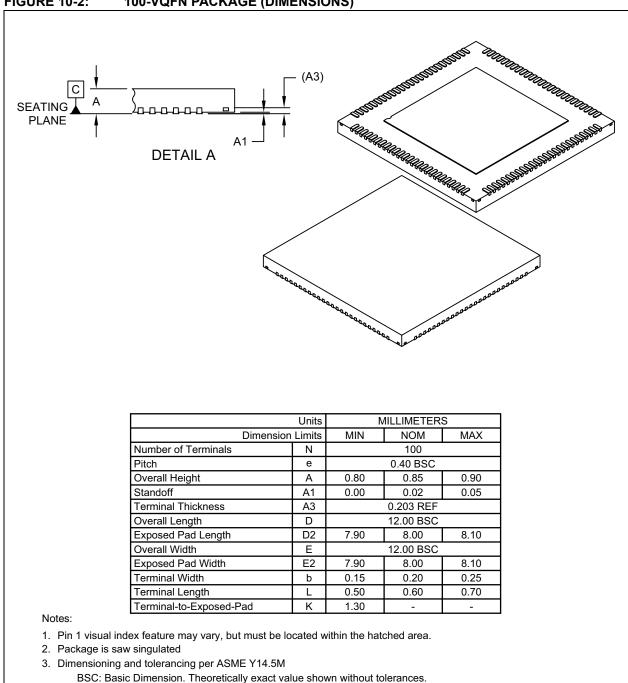


# 10.2 Package Drawings

**Note:** For the most current package drawings, see the Microchip Packaging Specification at: http://www.microchip.com/packaging.





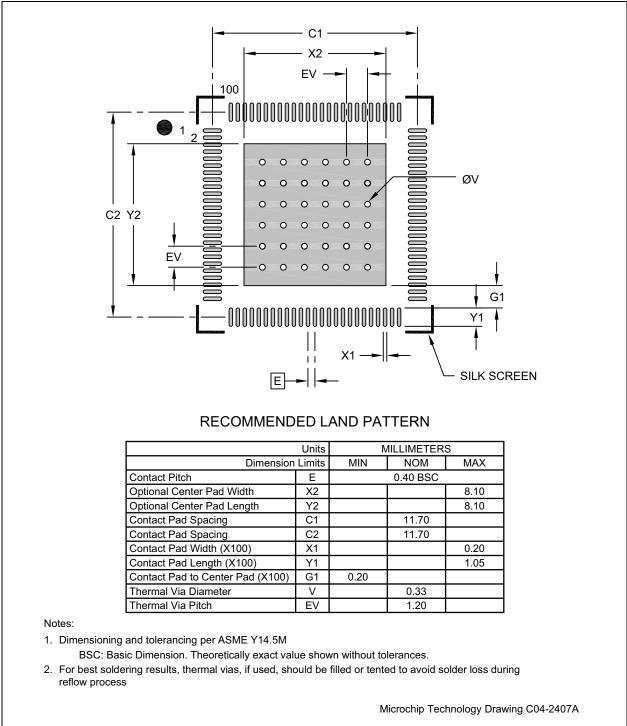


**FIGURE 10-2: 100-VQFN PACKAGE (DIMENSIONS)** 

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-407 Rev B Sheet 2 of 2





# APPENDIX A: REVISION HISTORY

# TABLE A-1: REVISION HISTORY

<b>Revision Level &amp; Date</b>	Section/Figure/Entry	Correction
DS00002243D (05-21-18)	Table 3-6	Added pull-down (PD) to buffer type of C_AT- TACH[0:2], AB[0:1], CC_POL, ALT_MUX- _EN, ATTACH_MUX[0:1]A, ATTACH_MUX[0:1]B pins.
	Table 3-6	Corrected the <b>AB[0:1]</b> 0 and 1 state descriptions.
	Section 8.7.2.1, Enabling Port Split- ting	Updated section and added USB3_PORT_SPLIT_EN register information.
DS00002243C (08-18-17)	Figure 10-1, Figure 10-2, Figure 10-3	Updated package drawings.
	Cover, Section 2.1, General Descrip- tion, Section 8.0, Functional Descrip- tions	Removed references to FlexConnect.
	Section 3.2, Pin Symbols, Figure 3-1, Table 3-4	Removed references to FLEX_CMD and FLEX_STATE pins.
	Section 3.2, Pin Symbols, Figure 3-1, Table 3-4	Removed references to PRT_CTL0 pin.
	Table 9-10	Updated max equivalent series resistance to 60Ω.
	Table 9-3	Updated values.
DS00002234B (01-20-17)	Figure 4-2, SPI ROM Connections	Modified drawing by changing position of DO to DI and DI to DO
	Table 9-3, Device Power Consump- tion	Typical power consumption formula added below table.
	Section 8.7.2.1, Enabling Port Split- ting	Options A and B added.
	Throughout data sheet	Changed 62kOhm to 50kOhm
	Table 3-1, Pin Reset State Legend	In PD-15k, changed "Hardware enables inter- nal 62kOhm pull-down" to "Hardware enables internal 15kOhm pull-down"
	Section 3.2, Pin Symbols	Updated pin names for pin numbers: 51, 52, 57, 58 and 62
	Figure 3-1 Pin Assignments (Top View)	
DS00002234A (10-03-16)	All	Initial Release

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PART NO. Device	[X] <sup>(1)</sup> [-X] /XX T T Tape and Reel Temperature Package Option Range	Examples: a) USB5916/KD Tray, Commercial temp., 100-pin VQFN b) USB5916-I/KD Tray, Industrial temp., 100-pin VQFN
Device:	USB5916	<ul> <li>c) USB5916T/KD</li> <li>Tape &amp; reel, Commercial temp., 100-pin VQFN</li> <li>d) USB5916T-I/KD</li> </ul>
Tape and Reel Option:	Blank = Standard packaging (tube or tray) T = Tape and Reel <sup>(1)</sup>	Tape & reel, Industrial temp., 100-pin VQFN
Temperature Range:	Blank = 0°C to +70°C (Commercial) I = -40°C to +85°C (Industrial)	
Package:	KD = 100-pin VQFN	Note 1: Tape and Reel identifier only appears in the catalog part number description. This identifier is used for ordering purposes and is not printed on the device package. Check with your Microchip Sales Office for package availability with the Tape and Reel option.

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